THE VLSI IMPLEMENTATION AND EVALUATION OF AREA- AND ENERGY-EFFICIENT STREAMING MEDIA PROCESSORS

A DISSERTATION SUBMITTED TO THE DEPARTMENT OF ELECTRICAL ENGINEERING AND THE COMMITTEE ON GRADUATE STUDIES OF STANFORD UNIVERSITY IN PARTIAL FULFILLMENT OF THE REQUIREMENTS FOR THE DEGREE OF DOCTOR OF PHILOSOPHY

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Abstract

Media applications such as image processing, signal processing, and graphics require tens to hundreds of billions of arithmetic operations per second of sustained performance for real-time application rates, yet also have tight power constraints in many systems. For this reason, these applications often use special-purpose (fixed-function) processors, such as graphics processors in desktop systems. These processors provide several orders of magnitude higher performance efficiency (performance per unit area and performance per unit power) than conventional programmable processors.

In this dissertation, we present the VLSI implementation and evaluation of stream processors, which reduce this performance efficiency gap while retaining full programmability. *Imagine* is the first implementation of a stream processor. It contains 48 32-bit arithmetic units supporting floating-point and integer data-types organized into eight SIMD arithmetic clusters. Imagine executes applications stream programs consisting of a sequence of computation kernels operating on streams of data records. The prototype Imagine processor is a 21-million transistor chip, implemented in a 0.15 micron CMOS process. At 232 MHz, a peak performance of 9.3 GFLOPS is achieved while dissipating 6.4 Watts with a die size measuring 16 mm on a side.

Furthermore, we extend these experimental results from Imagine to stream processors designed in more area- and energy-efficient custom design methodologies and to future VLSI technologies where thousands of arithmetic units on a single chip will be feasible. Two techniques for increasing the number of arithmetic units in a stream processor are presented: intracluster and intercluster scaling. These scaling techniques are shown to provide high performance efficiencies to tens of ALUs per cluster and to hundreds of arithmetic clusters, demonstrating the viability of stream processing for many years to come.

Acknowledgments

During the course of my studies at Stanford University, I have been fortunate to work with a number of talented individuals. First and foremost, thanks goes to my research advisor, Professor William J. Dally. Through his vision and leadership, Bill has always been an inspiration to me and everyone else on the Imagine project. He also provided irreplacable guidance for me when I needed to eventually find a dissertation topic. Professor Dally provided me with the opportunity to take a leadership role on the VLSI implementation of the Imagine processor, an invaluable experience for which I will always be grateful. I would also like to thanks the other members of my reading committee, Professor Mark Horowitz and Professor Teresa Meng, for their valuable feedback regarding the work described in this dissertation and interactions over my years at Stanford.

The Imagine project was the product of the hard work of many graduate students in the Concurrent VLSI Architecture group at Stanford. Most notably, I would like to thank Scott Rixner, Ujval Kapasi, John Owens, and Peter Mattson. Together, we formed a team that took the Imagine project from a research idea to a working silicon prototype. More recently, Jung-Ho Ahn, Abhishek Das, and Ben Serebrin have helped with laboratory measurements. Thanks also goes to all of the other team members who helped with the Imagine VLSI implementation, including Jinyung Namkoong, Brian Towles, Abelardo Lopez-Lagunas, Andrew Chang, Ghazi Ben Amor, and Mohamed Kilani.

I would also like to thank all of the other members of the CVA group at Stanford, especially my officemates over the years: Ming-Ju Edward Lee, Li-Shiuan Peh, and Patrick Chiang. Many thanks also goes to Pamela Elliot and Shelley Russell, the CVA group administrators while I was a graduate student here.

The research described in this dissertation would not have been possible without the

generous funding provide by a number of sources. I would like to specifically thank the Intel Foundation for a one-year fellowship in 2001-2002 to support this research. The remainder of my time as a graduate student, I was supported by the Imagine project, which was funded by the Defense Advanced Research Projects Agency under ARPA order E254 and monitored by the Army Intelligence Center under contract DABT63-96-C0037, by ARPA order L172 monitored by the Department of the Air Force under contract F29601-00-2-0085, by Intel Corporation, by Texas Instruments, and by the Interconnect Focus Center Program for Gigascale Integration under DARPA Grant MDA972-99-1-0002.

Finally, I can not say enough about the support provided by my friends and family. My parents, Asad (the first Dr. Khailany) and Laura, have been my biggest supporters and for that I am forever grateful. Now that they will no longer be able to ask me when my thesis will be done we will have to find a new subject to discuss on the telephone. My sister and brother, Raygar and Sheilan, have always providing timely encouragement and advice. To all of my friends and family members who have helped me in one way or another over the years, I would like to say thanks.

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Chapter 1

Introduction

Computing devices and applications have recently emerged to interface with, operate on, and process data from real-world samples classified as *media*. As media applications operating on these data-types have come to the forefront, the design of processors optimized to operate on these applications have emerged as an important research area. Traditional microprocessors have been optimized to execute applications from desktop computing workloads. Media applications are a workload with significantly different characteristics, meaning that the potential for large improvements in performance, cost, and power efficiency can be achieved by improving media processors.

Media applications include workloads from the areas of signal processing, image processing, video encoding and decoding, and computer graphics. These workloads require a large and growing amount of arithmetic performance. For example, many current computer graphics and image processing applications in desktop systems require tens to hundreds of billions of arithmetic operations per second for real-time performance [Rixner, 2001]. As scene complexity, screen resolutions, and algorithmic complexity continues to grow, this demand for absolute performance will continue to increase. Similar examples of large and growing performance requirements can be drawn in the other application areas, such as the need for higher communication bandwidth rates in signal processing and higher video quality in video encoding and decoding algorithms. As a result, media processors must be designed to provide large amounts of absolute performance.

While high performance is necessary to meet the computational requirements of media

applications, many media processors will need to be deployed in mobile systems and other systems where cost and power consumption is a key concern. For this reason, low power consumption and high energy efficiency, or high performance per unit power (low average energy dissipated per arithmetic operation), must be a key design goal for any media processor.

Fixed-function processors have been able to provide both high performance and good energy-efficiency when compared to their programmable counterparts on media applications. For example, the Nvidia Geforce3 [Montrym and Moreton, 2002; Malachowsky, 2002], a recent graphics processor, provides 1.2 Teraops per second of peak performance at 12 Watts for an energy-efficiency of 10 picoJoules per operation. In comparison, programmable digital signal processors and microprocessors are several orders of magnitude worse in absolute performance and in energy efficiency. However, programmability is a key requirement in many systems where algorithms are too complex or change too rapidly to be built into fixed-function hardware. Using programmable rather than fixed-function processors also enables fast time-to-market. Finally, the cost of building fixed-function chips is growing significantly in deep sub-micron technologies, meaning that programmable solutions also have an inherent cost advantage since a single programmable chip can be used in many different systems. For these reasons, a programmable media processors is desirable.

Stream processors have recently been proposed as a solution that can provide all three of the above: performance, energy efficiency, and programmability. In this dissertation, the design and evaluation of a prototype stream processor, called *Imagine* is presented. This 21-million transistor processor is implemented in a 5-level metal 0.15 micron CMOS technology with a die size measuring 16 millimeters on a side. At 232 MHz, a peak performance of 9.3 GFLOPS is achieved while dissipating 6.4 Watts. Furthermore, in future VLSI technologies, the scalability of stream processors to Teraops per second of peak performance is demonstrated.

1.1 Contributions

This dissertation makes several contributions to the fields of computer architecture and media processing:

- The design and evaluation of the Imagine stream processor. This is the first VLSI implementation of a stream architecture and provides experimental verification to the VLSI feasibility and performance of stream processors.
- Analysis on the performance efficiency of stream processors. This analysis demonstrates the potential for providing high performance per unit area and high performance per unit power when compared to other media processor architectures.
- Analytical models for the area, power, and delay of key components of a stream processor. These models are used to demonstrate the scalability of stream processors to thousands of arithmetic units in future VLSI technologies.
- An analysis of the performance of media applications as the number of arithmetic units per stream processor are increased. This analysis provides insights into the available parallelism in media applications and explores the tradeoffs in area, power, and performance for different methods of scaling to large numbers of arithmetic units per stream processor.

1.2 Outline

Recently, media processing has gained attention in both commercial products and academic research. The important recent trends in media processing are presented in Chapter 2. One such trend which has gained prominence in the research community is stream processing. In Chapter 2, we introduce and explain stream processing, which consists of a programming model and architecture that enables high performance on media applications with fully-programmable processors.

In order to explore the performance and efficiency of stream processing, a prototype stream processor, *Imagine*, was designed and implemented in a modern VLSI technology.

In Chapter 3, the instruction set architecture, microarchitecture, and key arithmetic circuits from Imagine are described. In Chapter 4, the design methodology is presented and finally, in Chapter 5, experimental results are provided. Also in Chapter 5, the energy efficiency of Imagine and a comparison to existing processors is presented.

This work on Imagine was then extended to study the scalability of stream processors to future VLSI technologies when thousands of arithmetic units could fit on a single chip. In Chapter 6, analytical models for the area, power, and delay of key components of a stream processor are presented. These models are then used to explore how area and energy efficiency scales with the number of arithmetic units. In Chapter 7, performance scalability is studied by exploring the available parallelism in media applications and by exploring the tradeoffs between different methods of scaling.

Finally, conclusions and future work are presented in Chapter 8.

Chapter 2

Background

Media applications and media processors have recently become an active and important area of research. In this chapter, background and previous work on media processing is presented. First, media application characteristics and previous work on processors for running these applications is presented. Then, stream processors are introduced. Stream processors have recently been proposed as an architecture that exploits media application characteristics to achieve better performance, area efficiency, and energy efficiency than existing programmable processors.

2.1 Media Applications

Media applications are programs with real-time performance requirements that are used to process audio, video, still images, and other data-intensive data. Example application domains include image processing, computer-generated graphics, video encoding or decoding, and signal processing. As previous researchers have pointed out, these applications share several important characteristics: compute intensity, parallelism, and locality [Rixner, 2001].

A flow-diagram representation of one such media application, a stereo depth extractor, is shown graphically in Figure 2.1 [Kanade *et al.*, 1996]. In this application, using two images offset by a horizontal disparity as input from two cameras, each row from each image is first filtered and then compared using a sum-of-absolute differences metric to



Figure 2.1: A Stereo Depth Extractor

estimate the disparity between objects in the images. From the disparity calculated at each image pixel, the depth of objects in an image can be approximated. This stereo depth extractor will be used to demonstrate the three important characteristics common to most media applications.

2.1.1 Compute Intensity

The first important characteristic is compute intensity, meaning that media applications require a high number of arithmetic operations per memory reference when compared to traditional desktop applications. Rixner studied application characteristics of four media applications: the stereo depth extractor presented above, a video encoder/decoder, a polygon renderer, and a matrix QR decomposition [Rixner, 2001]. On the stereo depth extractor, 473.3 arithmetic operations in the convolution filter and sum-of-absolute difference calculations were required per inherent memory reference (input, output, and other global data accesses). The other applications ranged between 57.9 and 155.3 arithmetic operations per memory reference. In comparison, traditional desktop integer applications have ratios of less than 2: arithmetic operations comprise between 2% and 50% of dynamically executed instructions whereas memory loads and stores account for 15% to 80% of instructions in the SPECint2000 benchmark suite [KleinOsowski *et al.*, 2000]. This difference suggests that architectures optimized for integer benchmarks such as general-purpose microprocessors would not be as well-suited to media applications and vice versa.

2.1.2 Parallelism

Not only do these applications require large numbers of arithmetic operations per memory reference, but many of these arithmetic operations can be executed in parallel. This available parallelism in media applications can be classified into three categories: instruction-level parallelism (ILP), data-level parallelism (DLP), and task-level parallelism (TLP).

The most plentiful parallelism in media applications is at the data level. DLP refers to computation on different data elements occurring in parallel. Furthermore, DLP in media applications can often be exploited with SIMD execution since the same computation is typically applied to all data elements. For example, in the stereo depth extractor, all output pixels in the depth map could theoretically be computed in parallel by the same fixed-function hardware element since there are no dependencies between these pixels and the computation required for every pixel is the same. Other media applications also contain large degrees of DLP.

Some parallelism also is available at the instruction level. In the stereo depth extractor, ILP refers to the parallel execution of individual arithmetic instructions in the convolution filter or sum-of-absolute differences calculation. For example, the convolution filter computes the product of a coefficient matrix with a sequence of pixels. This matrix-vector product includes a number of multiplies and adds that could be performed in parallel. Such fine-grained parallelism between individual arithmetic operations operating on one data element is classified as ILP and can be exploited in many media applications. As will be shown later in Chapter 7, available ILP in media applications is usually limited to a few instructions per cycle due to dependencies between instructions. Although other researchers have shown that out-of-order superscalar microprocessors are able to execute up to 4.2 instructions per cycle on some media benchmarks [Ranganathan *et al.*, 1999], this is largely due to DLP being converted to ILP with compiler or hardware techniques rather than the true ILP that exists in these applications.

Finally, the stereo depth extractor and other media applications also contain task-level, or thread-level, parallelism. TLP refers to different stages of a computation pipeline being overlapped. For example, in the stereo depth extractor, there are four exeuction stages: load image data, convolution filter, sum-of-absolute differences, and store output data. TLP is

available in this application because these execution stages could be set up as a pipeline where each stage concurrently processes different portions of the dataset. For example, a pipeline could be set up where each stage operates on a different row: the fourth image rows are loaded from memory, the convolution filter operates on the third rows, sum-of-absolute differences is computed between the second rows, while the first output row is stored back to memory. Note that ILP, DLP, and TLP are all orthogonal types of parallelism, meaning that all three could theoretically be supported simultaneously.

2.1.3 Locality

In addition to compute intensity and parallelism, the other important media application characteristic is locality of reference for data accesses. This locality can be classified into kernel locality and producer-consumer locality. Kernel locality is temporal and refers to reuse of coefficients or data during the execution of computation kernels such as the convolution filter. Producer-consumer locality is also a form of temporal locality that exists between different stages of a computation pipeline or kernels. It refers to data which is *produced*, or written, by one kernel and *consumed*, or read, by another kernel and is never read again. This form of locality is seen very frequently in media applications [Rixner, 2001]. In a traditional microprocessor, kernel locality would most often be captured in a register file or a small first-level cache. Producer-consumer locality on the other hand is not as easily captured by traditional cache hierarchies in microprocessors since it is not well-matched to least-recently-used replacement policies typically utilized in caches.

2.2 VLSI Technology

Not only has the typical application domain for programmable processors shifted over the last decade, the technology constraints of modern VLSI (Very Large Scale Integrated Circuits) has evolved as well. In the past, gates used for computation were the critical resource in VLSI design, but in modern technology, computation is cheap and communication between computational elements is expensive. For example, in the Imagine processor [Khailany *et al.*, 2002], a single-precision floating-point multiply-accumulate unit in a

0.18 μ m technology measures 0.486 mm^2 and dissipates 185 pJ per multiply (0.185 mW per MHz). A thousand of these multipliers could fit on a single die in a 0.13 μ m technology.

While arithmetic itself is cheap, handling the data and control communication between arithmetic units is expensive. On-chip communication between such arithmetic units requires storage and wires. Small distributed storage elements are not too expensive compared to arithmetic. In the same 0.18 μ m technology, a 16-word 32-bit, one-read-port one-write-port SRAM which is 0.0234 mm^2 and dissipates 15pJ per access cycle assuming both ports are active. However, as additional ports are added to this memory, the area cost increases significantly. Furthermore, the drivers and wires for a 32-bit 5 millimeter bus dissipate 24 pJ per transfer on average [Ho *et al.*, 2001]. If each multiply requires three multi-ported memory accesses and three 5 millimeter bus transfers (two reads and one write), then the cost of the communication is very similar to the cost of a multiply. Architectures must therefore manage this communication effectively in order to keep its area and energy costs from dominating the computation itself. Off-chip communication is an even more critical resource, since there are only hundreds of pins available in large chips today. In addition, each off-chip communication dissipates a lot of energy (typically over 1 nJ for a 32b transfer) when compared to arithmetic operations.

Although handling the cost of communication in modern VLSI technology is a challenge, media application characteristics are well-suited to take advantage of cheap computation with highly distributed storage with local communications. Cheap computation can be exploited with large numbers of arithmetic units to take advantage of both compute intensity and parallelism in these applications. Furthermore, producer-consumer locality can be exploited to keep communication local as much as possible, thereby minimizing communication costs.

2.3 Media Processing

Processors can exploit application characteristics to provide both high performance and more importantly, performance efficiency. High performance efficiency implies a high ratio of performance per unit area, *area efficiency*, and a high ratio of performance per unit power, *energy or power efficiency*. These metrics are often more important than raw performance in many media processing systems since higher area efficiency leads to low cost and better manufacturability, both important in embedded systems. Energy efficiency implies that for executing a fixed computation task, less energy from a power source such as a battery is used, leading to longer battery life and lower packaging costs in mobile products. In this section, we present previous work on fixed-function and programmable processors for media applications, with data on both performance and performance efficiency.

2.3.1 Special-purpose Processors

Special-purpose, or fixed-function, processors directly map an application's data-flow graph into hardware and can therefore exploit important application characteristics. They contain a large number of computation elements operating in parallel, exploiting both the compute intensity and parallelism in media applications. These computation blocks are then connected together by dedicated wires and memories, exploiting available producer-consumer locality. Using dedicated wires and memories for local storage near the computation elements is very area- and energy-efficient, since it minimizes traversals of long on-chip wires and accesses to large global multi-ported memories. As a result, a large percentage of die area and active power dissipation is allocated to the computation elements rather than control and communication structures.

An energy-efficiency comparison between a variety of fixed-function and programmable processors for media applications is shown in Table 2.1. All processors have been normalized to a 0.13 micron, 1.2 Volt technology. Energy efficiency is shown as energy per arithmetic operation and is calculated from peak performance and power dissipation. Although most processors sustain a fraction of peak performance on most applications, sustained performance and power dissipation measurements are not widely available, so peak numbers are used here.

The energy efficiency of two special-purpose media processors are listed in the first section of Table 2.1. A polygon rendering chip, the Nvidia Geforce3 [Montrym and More-ton, 2002; Malachowsky, 2002], and a MPEG4 [Ohashi *et al.*, 2002] video decoder are presented. These processors provide energy efficiencies of better than 6 pJ per arithmetic

2.3. MEDIA PROCESSING

Processor	Data-type	Peak Perf	Power	Energy/Op
Nvidia GeForce3	8-16b	1200 GOPS	6.7 W	5.5 pJ
MPEG4 Decode	8-16b	2 GOPS	6.2 mW	3.2 pJ
Intel Pentium 4	FP	12 GFLOPS	51.2 W	4266 pJ
(3.08 GHz)	16b	24 GOPS	51.2 W	2133 pJ
SB-1250	FP	12.8 GFLOPS	8.7 W	677 pJ
(800 MHz)	64b	6.4 GOPS	8.7 W	1354 pJ
	16b	12.8 GOPS	8.7 W	677 pJ
TI C67x (225 MHz)	FP	1.35 GFLOPS	1.2 W	889 pJ
TI C64x (600 MHz)	16b	4.8 GOPS	720 mW	150 pJ
VIRAM	FP	1.6 GFLOPS	1.4 W	875 pJ
	16b	9.6 GOPS	1.4 W	146 pJ

Table 2.1: Media Processor Efficiencies (Normalized to 0.13μ , 1.2 V)

operation when normalized to a 0.13 μ m technology. The other processors in Table 2.1 are all programmable. Although area efficiencies are not provided in the table, comparisons between processors for energy efficiency should be similar to area efficiency. As can be seen, there is an efficiency gap of several orders of magnitude between the special-purpose and programmable processors. The remainder of this section will provide background into these programmable processors and explain their performance efficiency limitations.

2.3.2 Microprocessors

The second section of Table 2.1 includes two microprocessors, a 3.08 GHz Intel Pentium 4¹ [Sager *et al.*, 2001; Intel, 2002] and a SiByte SB-1250, which consists of two on-chip SB-1 CPU cores [Sibyte, 2000]. The Pentium 4 is designed for high performance through deep pipelining and high clock rate. The SiByte processor is targeted specifically for energy efficient operation through extensive use low power design techniques, and has efficiencies similar to other low power microprocessors, such as XScale [Clark *et al.*, 2001]. These

¹Gate length for this process is actually 60-70 nanometers because of poly profiling engineering [Tyagi *et al.*, 2000; Thompson *et al.*, 2001].

processors demonstrate the range of energy efficiencies typically provided by microprocessors, over 500 pJ per instruction when normalized to a 0.13 micron technology.

Microprocessors have markedly lower efficiencies than special-purpose processors because of deep pipelining and because of the large amount of area and power taken up by control structures and large global memories such as caches. For example, less than 15% of die area in the Pentium 3 [Green, 2000], the predecessor to the Pentium 4, is devoted to the arithmetic execution units. In addition, deep pipelining with over 20 pipeline stages, used in the Pentium 4, requires high clock power, large branch predictors, and speculative hardware in order to achieve high performance at the expense of energy efficiency. The Sibyte processor is limited to more modest pipeline lengths for energy efficiency, but still is based around an architecture with a global register file and global communications through a cache hierarchy. Caches in microprocessors are not optimized to directly take advantage of producer-consumer locality to increase available on-chip bandwidth, but rather are optimized to exploit temporal and spatial locality to reduce average memory latency.

In addition to energy inefficiencies in control structures, pipelining, and caches, existing microprocessor architectures are unable to take advantage of the compute intensity or parallelism in media applications. A single unified multi-ported register file does not scale efficiently to tens of arithmetic units, limiting the compute intensity and parallelism that can be exploited. Furthermore, microprocessors are mainly optimized to exploit ILP, less plentiful than the highly available DLP in media applications. Recently, microprocessors have tried to exploit DLP to achieve higher performance and to overcome register file scalability limitations by adding SIMD extensions to their instruction sets. Some example ISA extensions include VIS [Tremblay *et al.*, 1996], MAX-2 [Lee, 1996], MMX [Peleg and Weiser, 1996], Altivec [Phillip, 1998], SSE [Thakkar and Huff, 1999], and others. However, the amount of data parallelism exploited by SIMD extensions is limited to the width of SIMD arithmetic units, typically less than 4 parallel data elements. This means each SIMD instruction can only capture a small percentage of the DLP available in media applications [Kozyrakis, 2002].

2.3.3 Digital Signal Processors and Programmable Media Processors

Digital signal processors are listed next in Table 5.1. The first DSP, the TI C67x [TI, 2003], is an 8-way VLIW operating at 225 MHz that targets floating-point applications, and has energy efficiency of 889 pJ per instruction. DSPs targeted for lower-precision fixed-point operation such as the TI C64x [Agarwala *et al.*, 2002], a 600 MHz 8-way VLIW, are able to provide improved energy efficiency over floating-point DSPs and microprocessors when normalized to the same technology, achieving 150 pJ per 16b operation. This improved efficiency is due to arithmetic units optimized for lower-precision fixed-point operation and with SIMD extensions in the C64x. In addition to C6x DSPs, there are a number of other VLIW DSPs and programmable media processors which achieve similar energy efficiencies such as the Analog TigerSharc [Olofsson and Lange, 2002], Trimedia [Rathnam and Slavenburg, 1996], the Starcore DSP [Brooks and Shearer, 2000], and others.

DSPs, programmable media processors, and special-purpose processors provide an energy efficiency advantage over microprocessors because they have kept pipeline lengths small and avoided speculative branch predictors for energy efficiency purposes. However, VLIW DSP architectures are not able to scale to tens of ALUs per processor, because they still rely on global register file and control structures in VLIW or superscalar microarchitectures. They also only exploit ILP and limited amounts of DLP through SIMD extensions, similar to microprocessors. As a result, they have area and energy efficiencies significantly better than general-purpose energy-inefficient microprocessors, but are still one to two orders of magnitude worse than special-purpose processors.

2.3.4 Vector Microprocessors

While SIMD extensions enable microprocessors and DSPs to exploit a small degree of DLP, vector processors [Russell, 1978] can exploit much more data parallelism directly with vector instructions and vector memory systems. As technology has advanced, vector processors on a single chip, or vector microprocessors have been become feasible [Wawrzynek *et al.*, 1996]. Recently, researchers have studied the use of vector microprocessors for media applications such as VIRAM [Kozyrakis, 2002] and others [Lee and Stoodley, 1998]. The performance and energy efficiency of VIRAM is shown in Table 5.1. It is able to provide

energy efficiencies competitive with DSPs at higher performance rates because of its ability to efficiently exploit DLP and its embedded memory system.

Vector processors directly exploit data parallelism by executing vector instructions such as vector adds or multiplies out of a vector register file. These vector instructions are similar to SIMD extensions in that they exploit inner-loop data parallelism in media applications, however, vector lengths are not constrained by the width of the vector units, allowing even more DLP to be exploited. Furthermore, vector memory systems are suitable for media processing because they are optimized for bandwidth and predictable strided accesses rather than conventional processors whose memory systems are optimized for reducing latency. For these reasons, vector processors are able to exploit significant data parallelism and compute intensity in media applications.

2.3.5 Chip Multiprocessors

Whereas vector microprocessors use SIMD execution to exploit DLP and achieve higher compute intensities, another approach to providing high arithmetic performance is chip multiprocessors (CMPs). In these solutions, multiple processor cores on the same chip each have their own thread of execution and mechanisms for on-chip communication and synchronization are provided. Some example research CMPs include RAW [Waingold *et al.*, 1997], Smart Memories [Mai *et al.*, 2000], and others. Other CMPs such as the Cradle 3SOC [Cradle, 2003] and Broadcom's Calisto (formerly Silicon Spice) [Nickolls *et al.*, 2002] have been proposed to specifically target lower-precision digital signal processing applications.

During media application execution, CMPs typically use thread-level parallelism to achieve high arithmetic performance by statically assigning tasks to some subset of the available on-chip cores. They can also use SIMD execution of multiple cores to exploit data parallelism within each task. Finally, CMPs are able to exploit producer-consumer locality by passing the output of one task directly to the input of another task without accessing global or off-chip memories. For all of these reasons, CMPs are able to provide arithmetic performance significantly higher than current DSPs or microprocessors by exploiting thread-level parallelism. As shown above, there are a wide variety of processors that can be used to run media applications. Special-purpose processors are inflexible, but are matched to both VLSI technology and media application characteristics. As a result, there is a large and growing gap between the performance efficiency of these fixed-function processors and programmable processors. The next section introduces stream processors as a way to bridge this efficiency gap.

2.4 Stream Processing

Stream processors are fully programmable processors that exploit the compute intensity, parallelism, and producer-consumer locality in media applications to provide performance efficiencies comparable to special-purpose processors [Rixner *et al.*, 1998; Khailany *et al.*, 2001; Rixner, 2001]. With stream processing, applications are expressed as *stream programs*, exposing the locality and parallelism inherent in media applications. A stream processor can then efficiently exploit the exposed locality with a bandwidth hierarchy of register files and can exploit the exposed parallelism with SIMD arithmetic clusters and multiple arithmetic units per cluster.

2.4.1 Stream Programming

Media applications are naturally cast as stream programs. A stream program organizes data as *streams* and computation as a sequence of *kernels*. A stream is a finite sequence of related elements. Stream elements are records, such as 21-word triangles, or single-word RGBA pixels. A kernel reads from a set of input streams, performs the same computation on all elements of a stream, and writes a set of output streams. The stereo depth extractor when mapped into a stream program is shown in Figure 2.2. Arrows represent streams and circles represent kernels. In this application, each stream is a row of grayscale pixels. The convolution stage of the application is broken into two kernels: a 7x7 blurring filter followed by a 3x3 sharpen filter. The resulting streams are sent to the SAD kernel which computes the best disparity match in a row and outputs a row of pixels from a depth map.



Figure 1: Stereo Depth Extraction

Figure 2.2: Stereo depth extractor as a stream program

Stream programs expose the locality and parallelism in the algorithm to the compiler and hardware. Two key types of locality are exposed: kernel locality and producerconsumer locality. Kernel locality refers to intermediate data values that are live for only a short time during kernel execution, such as temporaries during a convolution filter computation. Producer-consumer locality refers to streams produced by one kernel and consumed by subsequent kernels. Finally, parallelism is exposed because a kernel typically executes the same kernel program on all elements of an input stream. By casting media applications as stream programs, hardware is able to take advantage of the abundant parallelism, compute intensity, and locality in media applications.

2.4.2 Stream Architecture

The Imagine stream processor architecture, which is optimized to take advantage of the application characteristics exposed by the stream programming model is shown graphically in Figure 2.3. A stream processor runs as a coprocessor to a host executing scalar code.



Figure 2.3: Stream Processor Block Diagram

Instructions sent to the stream processor from the host are sequenced through a stream controller. The stream register file (SRF) is a large on-chip storage for streams. The microcontroller and ALU clusters execute kernels from a stream program. As shown in Figure 2.4, each cluster consists of ALUs fed by two local register files (LRFs) each, external ports for accessing the SRF, and an intracluster switch that connects the outputs of the ALUs and external ports to the inputs of the LRFs. In addition, there is a scratchpad (SP) unit, used for small indexed addressing operations within a cluster, and an intercluster communication (COMM) unit, used to exchange data between clusters. Imagine is a stream processor recently designed at Stanford University that contains six floating-point ALUs per cluster (three adders, two multipliers, and one divide-square-root unit) and eight clusters [Khailany *et al.*, 2001], and was fabricated in a CMOS technology with 0.18 micron metal spacing rules and 0.15 micron drawn gate length.



Figure 2.4: Arithmetic Cluster Block Diagram

Stream processors directly execute stream programs. Streams are loaded and stored from off-chip memory into the SRF. SIMD execution of kernels occurs in the arithmetic clusters. Although the stream processor in Figure 2.3 conatins eight arithmetic clusters, in general, the stream processor architecture can contain an arbitrary number of arithmetic clusters, represented by the variable C. For each iteration of a loop in a kernel, C clusters will read C elements in parallel from an input stream residing in the SRF, perform the exact same series of computations as specified by the kernel inner loop, and write C output elements in parallel back to an output stream in the SRF. Kernels repeat this for several loop iterations until all elements of the input stream have been read and operated on. Data-dependent conditionals in kernels are handled with conditional streams which, like predication, keep control flow in the kernel simple [Kapasi *et al.*, 2000]. However, conditional streams eliminate the extra computation required by predication by converting data-dependent control flow decisions into data-routing decisions.

Stream processors exploit parallelism and locality at both the kernel level and application level. During kernel execution, data-level parallelism is exploited with C clusters concurrently operating on C elements and instruction-level parallelism is exploited by VLIW execution within the clusters. At the application level, stream loads and stores can be overlapped with kernel execution, providing more concurrency. Kernel locality is exploited by stream processors because all temporary values produced and consumed during a kernel are stored in the cluster LRFs without accessing the SRF. At the application level,

2.4. STREAM PROCESSING

producer-consumer locality is exploited when streams are passed between subsequent kernels through the SRF, without going back to external memory.

The data in media applications that exhibits kernel locality and producer-consumer locality also has high data bandwidth requirements when compared to available off-chip memory bandwidth. Stream processors are able to support these large bandwidth requirements because their register files provide a three-tiered data bandwidth hierarchy. The first tier is the external memory system, optimized to take advantage of the predictable memory access patterns found in streams [Rixner et al., 2000a]. The available bandwidth in this stage of the hierarchy is limited by pin bandwidth and external DRAM bandwidth. Typically, during a stream program, external memory is only referenced for global data accesses such as input/output data. Programs are strip-mined so that the processor reads only one batch of the input dataset at a time. The second tier of the bandwidth hierarchy is the SRF, which is used to transfer streams between kernels in a stream program. Its bandwidth is limited by the available bandwidth of on-chip SRAMs. The third tier of the bandwidth hierarchy is the cluster LRFs and the intracluster switch between the LRFs which forwards intermediate data in a kernel between the ALUs in each cluster during kernel execution. The available bandwidth in this tier of the hierarchy is limited by the number of ALUs one can fit on a chip and the size of the intracluster switch between the ALUs.

The peak bandwidth rates of the three tiers of the data bandwidth hierarchy are matched to the bandwidth demands in typical media applications. For example, the Imagine processor contains 40 fully-pipelined ALUs and provides 2.3 GB/s of external memory bandwidth, 19.2 GB/s of SRF bandwidth, and 326.4 GB/s of LRF bandwidth. As discussed in Section 2.1, some media applications such as the stereo depth extractor require over 400 inherent ALU operations per memory reference. Imagine supports a ratio of ALU operations to memory words referenced of 28. Therefore, not only are stream processors in today's technology with tens of ALUs able to exploit this compute intensity, but as VLSI capacity continues to scale at 70% annually and as memory bandwidth continues to increase at 25% annually, this suggests that stream processors with thousands of ALUs could provide significant speedups on media applications without becoming memory bandwidth limited.

2.4.3 Stream Processing Related Work

The stream processor architecture described above builds on previous work in data-parallel architectures and programming models.

Stream processors share with vector processors the ability to exploit large amounts of data paralellism and compute intensity, but they differ from vector processors in two key ways. First, vector processors execute simple vector instructions such as vector adds and multiplies on vectors located in the vector register file whereas stream processors execute microcode kernels in SIMD out of the stream register file. Second, the register file storage on a stream processor is split into the stream register file and local register files. These optimizations allow stream processors to both capture producer-consumer locality in the register file hierarchy and to provide improved scalability within the arithmetic clusters with the local register files. Related work in vector processors has explored the use of partitioned register files to improve their scalability [Kozyrakis and Patterson, 2003].

Although designing a programmable architecture to directly execute stream programs is new, programming models similar to the stream model have been proposed in previous work with fixed-function processors. One example of a fixed-function processor that directly executes the stream programming model is Cheops [Bove and Watlington, 1995]. It directly maps an application data-flow exposed by the stream programming model into hardware units and consists of a set of specialized stream processors where each processor accepts one or two data streams as input and produces one or two data streams as output. Data streams are either forwarded directly from one stream processor to the next according to the applications data-flow graph or transferred between memory and the stream processors.

Other researchers have proposed designing signal processing systems using signal flow graphs specified in Simulink [Simulink, 2002] or other programming models [Lee and Parks, 1995] that have many similarities with the stream programming model. With these systems, signal flow graphs can be synthesized to software running on DSPs [Bhattacharyya *et al.*, 1996; de Kock *et al.*, 2000] or can be mapped into fixed-function processors using hardware generators [Davis *et al.*, 2001]. Designing fixed-function processors with these techniques allows for high efficiency since available parallelism and producer-consumer

locality can easily be exploited. However, unlike programmable processors, fixed-function processors lack the flexibility to execute a wide variety of applications.

Recently, other researchers have applied these same techniques for exploiting parallelism and locality used in fixed-function processors to reconfigurable logic. Streams-C [Gokhale *et al.*, 2000] and others [Caspi *et al.*, 2001] have proposed mapping arithmetic kernels to blocks in FPGAs and mapping streams passed between kernels to FIFO-based communication channels between FPGA blocks. These techniques enable some degree of programmability with a high-level language and are able to exploit large amounts of parallelism in stream programs. However, this approach is inhibited by limitations in reconfigurable logic. When compared to fixed-function transistors, large area and energy overheads are incurred when a design is implemented in reconfigurable logic. Furthermore, since stream programs are being spatially mapped onto a fixed resource such as an FPGA, problems arise when applications are too complex to fit onto this fixed resource.

Finally, other researchers have also studied compiling and executing the stream programming model on chip multiprocessors. Streamit is a programming language that implements the stream model on the RAW CMP [Gordon *et al.*, 2002]. Like hardwired stream processors, CMPs executing compiled stream programs can exploit parallelism with threads and producer-consumer locality between processors to manage communication bandwidth effectively. Like CMPs, programmable stream processors also have the ability to exploit parallelism and locality. However, since CMPs are targeted to run a wide variety of applications and rely mostly on thread-level parallelism, they contain more general control and communication structures per processor. In contrast, stream processors are targeted specifically for media applications, and therefore can use data-parallel hardware to efficiently exploit the available parallelism and a register file organization to efficiently exploit the available locality.

2.4.4 VLSI Efficiency of Stream Processors

The bandwidth hierarchy provided by a stream architecture's register file organization allows stream processors to sustain a large percentage of peak performance with very modest off-chip memory bandwidth requirements. However, the other advantage of the register file organization is the area and energy efficiency derived from partitioning the register file storage into stream register files, arithmetic clusters, and local register files within the arithmetic clusters. This partitioning enables stream processors to scale to thousands of ALUs with significantly modest area and energy costs.

The area of a register file is the product of three terms: the number of registers R, the bits per register, and the size of a register cell. Asymptotically, with a large number of ports, each register cell has an area that grows with p^2 because one wire is needed in the word-line direction, and another wire needed in the bit-line direction per register file port. Register file energy per access follows similar trends. Therefore, a highly multi-ported register file has area and power that grows asymptotically with Rp^2 [Rixner *et al.*, 2000b]. A general-purpose processor containing N arithmetic units with a single centralized register file requires approximately 3N ports (two read ports for the operands and one wire port for the result per ALU). However, as N increases, working set sizes would also increase, meaning that R should also grow linearly with N. As a result, a single centralized multiported register file interconnecting N arithmetic units in a general-purpose microprocessor has area and power that grows with N^3 , and would quickly begin to dominate processor area and power. As a result, partitioning register files is necessary in order to efficiently scale to large numbers of arithmetic units per processor.

Historically, register file partitioning has been used extensively in programmable processors in order to improve scalability, area and energy efficiency, and to reduce wire delay effects. For example, the TI C6x [Agarwala *et al.*, 2002] is a VLIW architecture split into two partitions, each containing a single multi-ported register file connected to four arithmetic units. Even in high-performance microprocessors not necessarily targeted for energy efficient operation, such as the Alpha 21264 [Gieseke *et al.*, 1997], register file partitioning has been used. In the stream architecture, register file partitioning occurs along three dimensions: distributed register files within the clusters, SIMD register files across the clusters, and the stream register organization between the clusters and memory. In the remainder of this section, we explain how the register file partition of Imagine along these three dimensions improves area and energy efficiency and is related to previous work on partitioned register files.
Distributed Register Partitioning

The first register file partitioning in the stream architecture is along the ILP dimension within a cluster. Given N ALUs per cluster, a VLIW cluster with one centralized register file connected to all of the ALUs would grow with N^3 as explained above. However, by splitting this centralized multi-ported register file into an organization with one twoported LRF per ALU input within each arithmetic cluster, the area and power of the LRFs only grows with N, and the intracluster switch connecting the ALU outputs to the LRF inputs grows with N^2 asymptotically. The exact area efficiency, energy efficiency, and performance when scaling N on a stream architecture will be explored in more detail in Chapter 6.

The disadvantage of this approach is that the VLIW compiler must explicitly manage communications across this switch and must deal with replication of data across various LRFs [Mattson *et al.*, 2000]. However, using asymptotic models for area and energy of register files, Rixner et al. showed that for N = 8, this distributed register organization provides a 6.7x and an 8.7x reduction on area and energy efficiency respectively in the ALUs, register files, and switches² [Rixner *et al.*, 2000b].

Partitioned register files in VLIW processors and explicitly scheduled communications between these partitions were proposed on a number of previous processors. For example, the TI C6x [Agarwala *et al.*, 2002] contains two partitions with four arithmetic units per partition. In addition, a number of earlier architectures used partitioned register files of various granularities. The Polycyclic architecture [Rau *et al.*, 1982], the Cydra [Rau *et al.*, 1989], and Transport-triggered architectures [Janssen and Corporaal, 1995] all had distributed register file organizations.

SIMD Register Partitioning

Whereas the distributed register partitioning was along the ILP dimension and was handled by the VLIW compiler, the next partitioning in the stream architecture occurs in the DLP

²Implementation details such as design methodology or available wiring layers would affect the efficiency advantage of certain DRF organizations. For instance, comparing the efficiency of one four-ported LRF per ALU rather to one two-ported LRF per ALU input would provide different results depending on these implementation details.

dimension and corresponds to the SIMD arithmetic clusters. In an architecture with C SIMD clusters, each of these clusters requires interconnecting only N/C ALUs together. Therefore, the area and energy in each cluster's intracluster switch grows much more slowly as there are many fewer ALUs per cycle. The disadvantage is that the complexity of the intercluster switch grows as the number of clusters increases. This tradeoff will be explored in more detail in Chapter 6.

The other efficiency advantage of SIMD processing besides register file partitioning comes from amortizing control overhead. Only one instruction fetch unit and sequencer is required for *C* clusters. The area and efficiency gains achieved through SIMD-partitioned register files and by amortizing control over parallel vector lanes were first proposed on vector microprocessors, and are applied to the stream architecture register file organization as well. Furthermore, SIMD partitioning can be combined with distributed register partitioning, as demonstrated both in the Imagine stream processor and in the CODE vector microarchitecture [Kozyrakis and Patterson, 2003].

Separating the SRF storage from cluster storage

The third and final partition in the stream architecture register file is a split between storage for loads and stores and storage for intermediate buffering between individual ALU operations. This is accomplished by separating the SRF storage from the LRFs within each cluster. This splitting between the SRF and LRFs has two main advantages. First, staging data for loads and stores is capacity-limited because of long memory latencies, rather than bandwidth-limited, meaning that large memories with few ports can be used for the SRF whereas the capacity of the LRFs can be kept relatively small. Second, data can be staged in the SRF as streams, meaning that accesses to the SRF will be sequential and predictable. As a result, streambuffers can be used to prefetch data into and out of the SRF, much like streambuffers are often used to prefetch data from main memory in microprocessors [Jouppi, 1990]. As explained in Section 3.2.4, these streambuffers allow accesses to a stream from each SRF client to be aggregated into larger portions of a stream before they are read or written from the SRF, leading to a much more efficient use of the SRF bandwidth and a more area- and energy-efficient design.

VLSI Efficiency Summary

The stream architecture register file organization can be viewed as a combination of the above three register partitionings. Overall, these partitions each provide a large benefit in area and energy efficiency. When compared to a 48-ALU processor with a single unified register file, a C = 8 N = 6 stream processor takes 195 times less area and 430 times less energy. A performance degradation of 8% over a hypothetical centralized register file architecture is incurred due to SIMD instruction overheads and explicit data transfers between partitions [Rixner *et al.*, 2000b].

In summary, there is a large and growing gap between the area and energy efficiency of special-purpose and programmable processors on media applications. The stream architecture attempts to bridge that gap through its ability to exploit important application characteristics and its efficient register file organization.

Chapter 3

Imagine: Microarchitecture and Circuits

In the previous chapter, a stream processor architecture [Rixner *et al.*, 1998; Rixner, 2001] was introduced to bridge the efficiency gap between special-purpose an programmable processors. A stream processor's efficiency is derived from several architectural advantages over other programmable processors. The first advantage is a data bandwidth hierarchy for effectively dealing with limited external memory bandwidth that can also exploit compute intensity and producer-consumer locality in media applications. The next advantage is SIMD arithmetic clusters and multiple arithmetic units per cluster that can exploit both DLP and ILP in media processing kernels. Finally, the bandwidth hierarchy and SIMD arithmetic clusters are built around a area- and energy-efficient register file organization.

Although the previous analysis qualitatively demonstrates the efficiency of the stream architecture, in order to truly evaluate its performance efficiency, a VLSI prototype Imagine stream processor [Khailany *et al.*, 2001] was developed so that performance, power dissipation, and area could be measured. Not only did this prototype provide a vehicle for experimental measurements, but also, by implementing a stream processor in VLSI, key insights into the effect of technology on the microarchitecture are gained. These insights were then used to study the scalability of stream processors in Chapter 6 and Chapter 7.

The next few chapters discuss the Imagine prototype in detail. This chapter presents the instruction set architecture, microarchitecture, and circuits of key components from the Imagine stream processor. Chapter 5 discusses the design methodology used for Imagine, and finally, in Chapter 6, experimental results for Imagine are presented.

3.1 Instruction Set Architecture

The Imagine processor runs stream programs written in *KernelC* and *StreamC*. StreamC specifies how streams are passed between kernels and includes reads and writes from memory and I/O. KernelC contains the mathematical operations for the kernels. Software tools then compile StreamC and KernelC for execution into instructions from the stream-level and kernel-level instruction set architectures (ISAs). StreamC compilation involves high-level data-flow analysis at the stream level including SRF allocation and memory management [Mattson, 2001; Kapasi *et al.*, 2001]. KernelC compilation includes parsing, instruction scheduling, and managing the communication between ALUs and LRFs across the intracluster switch [Mattson *et al.*, 2000]. Once StreamC and KernelC have been compiled, the Imagine processor directly executes instructions from the stream and kernel level ISAs described below.

3.1.1 Stream-Level ISA

There are six main stream-level instructions:

- LOAD transfers streams from off-chip SDRAM to the SRF.
- STORE transfers streams from the SRF to off-chip DRAM.
- *RECEIVE* transfers streams from the network to the SRF.
- SEND transfers streams from the SRF to the network.
- *CLUSTER OP* executes a kernel in the arithmetic clusters that reads inputs streams from the SRF, computes output streams, and writes the output streams to the SRF.
- *LOAD MICROCODE* loads streams consisting of kernel microcode (576-bit VLIW instructions) from the SRF into the microcontroller instruction store (a total of 2,048 instructions).

In addition to the six main instructions listed above, there are other instructions for writes and reads to on-chip control registers which are inserted as needed by the streamlevel compiler. Streams must have lengths that are a multiple of eight (the number of



Figure 3.1: Imagine Arithmetic Cluster

clusters) and lengths from 0 to 8K words are supported, where each word is 32 bits. Stream instructions are fetched and dispatched by a host processor to a scoreboard in the on-chip stream controller. As will be described in Section 3.2.8, the stream controller issues stream instructions to the various on-chip units as their dependencies become satisfied and their resources become available.

3.1.2 Kernel-Level ISA

Kernel-level instructions are scheduled and assembled into VLIW instructions at compiletime, are sequenced by a microcontroller, and then are broadcast to and executed in eight SIMD arithmetic clusters. Each arithmetic cluster, detailed in Figure 3.1, contains eight functional units (plus the special JB and VAL units that are used for conditional streams [Kapasi *et al.*, 2000]). A small two-ported local register file (LRF) connects to each input of each functional unit. An intracluster switch connects the outputs of the functional units to the inputs of the LRFs.

Each function unit from Figure 3.1 executes instructions from the kernel-level instruction set, shown in Tables 3.1 and 3.2. Instructions are grouped by supported datatypes. A wide range of datatypes from fixed-point or integer to single-precision floating-point are supported in order to accommodate the demands of media applications. The first two columns in the Kernel ISA tables contain the instruction mnemonic and a brief summary of the operation performed. The third column specifies the latency of each operation and the fourth column specifies the supported functional unit(s). As will be explained in Section 3.2, all functional units except the DSQ unit are fully pipelined.

In addition to the function unit operations and the stream input/output instructions,

Ор	Description	Т	Unit				
Ops for Floating-Point Data-types							
FADD	Add	4	ADD				
FSUB	Subtract	4	ADD				
FABS	Absolute value	1	ADD				
FLT	Test <	2	ADD				
FLE	Test \leq	2	ADD				
FTOI	Convert to int (round-to-zero)	3	ADD				
FFRAC	Computes x-FTOI(x)	4	ADD				
ITOF	Convert int to floating-point	4	ADD				
FMUL	Multiply	4	MUL				
FDIV	Divide	17	DSQ				
FSQRT	Square root	16	DSQ				
Ops for 32b, 16b,	and 8b Datatypes						
IADD	Add	2	ADD				
ISUB	Subtract	2	ADD				
IABD/UABD	Absolute difference (integer/unsigned)	2	ADD				
ILT/ULT	Test < (integer/unsigned)	2	ADD				
ILE/ULE	Test \leq (integer/unsigned)	2	ADD				
IEQ	Test ==	1	ADD				
NEQ	Test ! =	1	ADD				
AND	Bitwise AND	1	ADD				
OR	Bitwise OR	1	ADD				
XOR	Bitwise XOR	1	ADD				
NOT	Bitwise invert	1	ADD				
Ops for 32b and 16b Datatypes							
IADDS/UADDS	Integer/Unsigned saturating add	2	ADD				
ISUBS/USUBS	Integer/Unsigned saturating subtract		ADD				
SHIFT	Logical shift		ADD				
SHIFTA	Arithmetic shift	1	ADD				
ROTATE	Rotate	1	ADD				
IMUL/UMUL	Integer/Unsigned multiply	4	MUL				
IMULR/UMULR	4	MUL					
Ops for 16b Datatypes							
IMULD/UMULDInteger/Unsigned multiply (32b outputs)4N							
Ops for 32b Datatypes							
IDIV/UDIV	22	DSQ					
IDIVR/UDIVR	Integer/Unsigned remainder	23*	DSQ				

Table 3.1: Kernel ISA - Part 1

Ор	Description	Τ	Unit				
Data Movement Ops							
SELECT	Multiplex based on cc	1	ALL				
NSELECT	Multiplex based on !cc	1	ALL				
CCTOI	Convert CC to int	1	ALL				
SHUFFLE	Shuffle bytes	1	ADD				
SHUFFLED	Shuffle bytes (two outputs)	1	MUL				
SPRD	Scratchpad read	2	SP				
SPWR	Scratchpad write	2	SP				
COMM	Cluster RF - controlled permute	1	COM				
COMMUCDATA	Same as comm w/ UC data input	1	COM				
COMMUCPERM	UC-controlled permute	1	COM				
Conditional Stream	m Ops						
INIT_CISTATE	Initialize JBRF entry for conditional input stream	1	JB				
INIT_COSTATE	Initialize JBRF entry for conditional output stream	1	JB				
GEN_CISTATE	Update JBRF entry with new state	1	JB				
GEN_COSTATE	Update JBRF entry with new state	1	JB				
GEN_COSTATE	Update JBRF entry with new state		JB				
SPCRD	Conditional scratchpad read		SP				
SPCWR	Conditional scratchpad write		SP				
INIT_VALID	Initialize valid unit for new conditional stream	1	VAL				
GEN_CCEND	Computes CC for end of conditional stream	1	VAL				
GEN_CCFLUSH	CCFLUSH Computes CC for end of conditional stream		VAL				
Stream Input/Outp	out Ops						
DATA_IN	Read from input stream		ΙΟ				
COND_IN_R	Conditional stream read - intermediate word in record		IO				
COND_IN_D	Conditional stream read - last word in record	3	ΙΟ				
DATA_OUT	Write to output stream		IO				
COND_OUT_R	Conditional stream write - intermediate word in record	1	ΙΟ				
COND_OUT_D	1	IO					
Microcontroller Ops							
LOOP	Branch to new PC (if last CHK was true)		UC				
NLOOP	Branch to new PC (if last CHK was false)		UC				
UC_DATA_IN	Load immediate into microcontroller RF		UC				
DEC_CHK_UCR	Decrement and zero-check microcontroller RF value		UC				
CHK_EOS	Check for end of stream	2	UC				
CHK_ANY	Check for true cc in any cluster	2	UC				
CHK_ALL	Check for true cc's in all clusters						
SYNCH	Synchronize with stream controller	1	UC				

|--|

the kernel-level instructions also control register file accesses and the intracluster switch. Register file reads are handled with an address field in the kernel-level ISA, while writes require both an address field and a software pipeline stage field. Finally, the kernel-level ISA controls the intracluster switch with a bus select field for each write port. This field specifies which function unit output or input port should be written into the register file for this instruction.

3.1.3 Kernel Instruction Format

Once KernelC is mapped into instructions from the kernel-level ISA and scheduled by the VLIW compiler, instructions are then assembled into the 576-bit format specified in Figure 3.2. There are fields for nine functional units (scratchpad, ALUs, MULs, DSQ, COMM, and JBVAL), the condition code register file (CC), explained in Section 3.2, as well as the microcontroller and eight stream input/output units (SB0:SB7). Each function unit field is further subdivided into sub-fields, containing an opcode, a CCRF read address, read addresses for both LRFs (LRF 0 Rd and LRF 1 Rd), write addresses for both LRFs (LRF 0 Wr and LRF 1 Wr), a software pipelining stage field associated with each LRF write port (LRF 0 Stg and LRF 1 Stg), and a bus select field for the LRF inputs that controls the intracluster switch (LRF 0 Bus and LRF 1 Bus).

The location of function unit fields within the instruction word corresponds roughly to floorplan placement of arithmetic units within an arithmetic cluster. This alignment reduces the length of control wires as instructions are fetched from the microcode store, decoded, and broadcast to the clusters.

3.2 Microarchitecture

In the previous chapter, the arhitecture of the Imagine stream processor, shown in Figure 2.3, and the basic execution of a stream processor was presented. In this section, this discussion is extended with microarchitectural details from the key components of the Imagine architecture. First, the microarchitecture and pipeline diagrams of the microcontroller and arithmetic clusters are presented. These units execute instructions from the



Figure 3.2: VLIW Instruction Format

kernel-level ISA. Next, both the stream register file microarchitecture and its pipeline diagram are described. Finally, we present the stream controller and the streaming memory system, the other major components of a stream processor.

3.2.1 Microcontroller

The microcontroller provides storage for the kernels' VLIW instructions, and sequences and issues these instructions to the arithmetic clusters during kernel execution. A block diagram of the Imagine microcontroller is shown in Figure 3.3. It is composed of nine banks of microcode storage as well as blocks for loading the microcode, sequencing instructions using a program counter, and instruction decode.

Each bank of microcode storage contains a single-ported SRAM where 64 bits of each 576-bit VLIW kernel instruction are stored. Since each bank contains a 128Kb SRAM, a total of 2K instructions can be stored at one time. In order to allow for microcode to be loaded during kernel execution without a performance penalty, two instructions are read at one time from the SRAM array. The first of these instructions is passed directly to the



To Microcontroller, SRF, Arithmetic Clusters

Figure 3.3: Microcontroller Block Diagram

instruction decoder. The second is stored in a register, so that it can be decoded in the next clock cycle without accessing the SRAM array again.

The microcode loader handles the loading of kernel instructions from the SRF to the microcode storage arrays. Since microcode is read from the SRF one word at a time, and 1152 bits of microcode must be written at a time, the microcode loader reads words from a stream in the SRF, then sends them to local buffers in one of the microcode store banks. Once these buffers have all been filled, the microcode loader requests access to write two instructions into the microcode storage banks. A controller, not shown in Figure 3.3, handles this arbitration and also controls the reading of instructions from the microcode storage and intermediate registers during kernel execution.

The instruction sequencer contains the program counter which is used to compute the addresses to be read from the microcode storage. At kernel startup, the program counter

is loaded with the address of the first kernel instruction, specified by the stream controller. As kernel execution proceeds, the program counter is either incremented or, on conditional branch instructions, a new address is computed and loaded into the program counter. Conditional branches are handled with the CHK and LOOP/NLOOP instructions. CHK instructions store a true or false value into a register inside the instruction sequencer. Based on the value of this register, LOOP instructions conditionally branch to a relative offset specified in the instruction field.

The final component of the microcontroller is the instruction decoder, which handles the squashing of register file writes, a key part of the software pipeline mechanism on Imagine. In the VLIW instruction, each register file write has a corresponding *stage* field, which allows the kernel scheduler to easily implement software pipeline priming and draining without a loop pre-amble and post-amble. The kernel scheduler assigns all register file writes to a software pipelining stage, and encodes this stage in the VLIW instruction as the LRF Stg. sub-field from Figure 3.2. During loops, the instruction decoder keeps track of which stages are currently active, and squashes register file writes from inactive stages. In addition to squashing register file writes, the instruction decoder also provides pipeline registers and buffers for each ALU and LRF's opcodes before they are distributed to the SIMD ALU clusters and the instruction decoder handles reads and writes from the microcontroller register file, which is used to store constants and cluster permutations in many kernels.

3.2.2 Arithmetic Clusters

As the microcontroller fetches and sequences VLIW instructions from the microcode storage, the eight SIMD arithmetic clusters on Imagine execute these instructions. As was shown in Figure 3.1, each cluster is composed of nine function units (3 ADDs, 2 MULs, 1 DSQ, 1 SP, 1 JB/VAL, 1 COM). A more detailed view of a function unit (FU) and its associated register files is shown in Figure 3.4.

Most FUs have two data inputs, one condition code (cc) input, and one output bus. Data in the arithmetic clusters is stored in the LRFs. The LRFs have one read port, one write port, and 16 entries each, except for the multiplier LRFs, which have 32 entries.

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Figure 3.5: Local Register File Implementation

Latches were used as the basic storage element for the LRFs, as shown in Figure 3.5. The multiplexer before the LRF output flip flop enables register file bypassing within the LRFs so that data written on one cycle can be read correctly by the FU in the subsequent cycle. Flip flop writes can be disabled by selecting the top feedback path through the multiplexer.

Each FU also contains a copy of the condition code register file (CCRF), not shown in Figure 3.1, but shown in the detailed view of Figure 3.4. Condition codes (CCs) are special data values generated by comparison instructions such as IEQ and FLT and are used with SELECT instructions and with conditional streams. Although there is only one CCRF in the ISA, each FU contains a local copy of the CCRF. During writes to the CCRF, data and write addresses are broadcast to each CCRF copy, whereas during reads, each FU reads locally from its own CCRF copy. This structure allows for a CCRF with as many read ports as there are FUs, yet does not incur any wire delay when accessing CCs shared between all of the FUs in a cluster.

Finally, data is exchanged between FUs via the intracluster switch. This switch is implemented as a full crossbar where each FU broadcasts its result bus(es) to every LRF in an arithmetic cluster. A multiplexer uses the bus select field for its associated LRF write port to select the correct FU result bus for the LRF write.

3.2.3 Kernel Execution Pipeline

The microcontroller and arithmetic clusters work together to execute kernels. As is typically done in most high-performance microprocessors, they operate in a pipelined manner in order to achieve higher instruction throughput. The kernel execution pipeline diagram in the microcontroller and arithmetic clusters is shown in Figure 3.6.

During the first two pipeline stages, FETCH1 and FETCH2, the microcontroller instruction sequencer sends the current program counter to the microcode storage banks and the VLIW instructions are fetched from the SRAMs. During the decode and distribute stage (DECODE/DIST), instructions are decoded and broadcast to the eight arithmetic clusters. Branches are resolved and branch targets are computed in this stage, and the new program counter is computed if necessary. Since this is the third pipeline stage, two branch delay slots are added to all LOOP instructions. During REG READ, more instruction decoding

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Figure 3.6: Kernel Execution Pipeline Diagram

occurs and LRFs are accessed locally in each arithmetic cluster. This is followed by the execute (EX) pipeline stages, which vary in length depending on the operation being executed. The last half-cycle of each function unit's last execute stage is used to traverse the intracluster switch, and then in the writeback (WB) stage, the register write occurs.

Although the clusters are statically scheduled by a VLIW compiler and sequenced by a single microcontroller, dynamic events during execution can cause the kernel execution pipeline to stall. Stalls are caused by one of three conditions: the SRF not being ready for a write to an output stream, the SRF not being ready for a read from an input stream, or a SYCNH instruction being executed by the microcontroller for synchronization with the host processor. When one of these stall conditions is encountered, all pipeline registers in the clusters and microcontroller are disabled and writes to machine state are squashed until a later cycle when the stall condition is no longer valid.

The microcontroller and arithmetic clusters work together to execute kernels from an application's stream program. They execute VLIW instructions made up of operations from the kernel-level ISA in a six-stage (or more for some operations) execution pipeline. The other main blocks in the Imagine processor are used to sequence and execute stream transfers from the stream-level ISA.



Figure 3.7: Stream Register File Block Diagram

3.2.4 Stream Register File

The stream register file (SRF), provides on-chip data storage for streams. The SRF is used during execution to stage data both between stream-level memory and kernel operations and between subsequent kernel operations. As shown in Figure 3.7, the SRF is partitioned into eight parallel banks, where each bank is aligned to an associated cluster. Streams are stored in the SRF with their records strided across the eight banks: bank 0 would contain records 0, 8, 16, ..., bank 1 would contain records 1, 9, 17, ..., and so on for banks 2 through 8. Each SRF bank can store up to 4K words, for a total of 32K words.

Each SRF bank contains a single-ported 128kb SRAM and 22 streambuffer (SB) banks. The SBs are used to interface between the SRF storage and the 22 SRF clients (8 cluster, 8 network, 1 microcontroller, 1 host, 2 memory data, and 2 memory index streams)¹. Using streambuffers as these clients' interface to the SRF takes advantage of the predictable streaming nature of accesses to enable an area- and energy-efficient SRF implementation [Rixner *et al.*, 2000b]. Clients make requests to the streambuffers to read or write elements from a stream. SBs in turn make requests to access the location in the SRF storage where that stream resides. These requests are handled by a 22:1 arbiter in SRF control. One SB is granted access per cycle and all eight banks from the chosen SB read or write 4 words into half of their local storage (each SB contains 8 words of storage to allow for double buffering). Finally, the external clients can read or write data from their associated streambuffer at a lower bandwidth. In this manner, the SBs enable the SRAM's single physical port to function as 22 logical ports, but in a more area- and energy-efficient manner than a multi-ported SRAM.

3.2.5 SRF Pipeline

Not only is kernel execution pipelined in order to provide higher instruction throughput, but the SRF is also pipelined to provide high-throughput access to the SRF storage. The pipeline diagram for the SRF is shown in Figure 3.8, and is designed to operate at half the

¹Each client accesses its streambuffers in a slightly different manner. The clusters read or write 8 words from each streambuffer in parallel from each cluster for a peak supported throughput of 8 words per cycle per streambuffer. Although the network has 8 SBs, only 2 can be active on a given cycle, and only 2 words per SB can be read. All of the other streambuffers support 1 word per cycle.



Figure 3.8: SRF Pipeline Diagram

frequency of the kernel pipeline, in order to ease timing constraints, and therefore reduce overall design effort.

The SRF pipeline consists of three stages: stream select (SEL), memory access (MEM), and streambuffer writeback (WB). During the SEL stage, SBs arbitrate for access to the SRAM array, and one of the SBs is granted access. Meanwhile the arbiter state is updated using a last-used-last-served scheme to ensure fairness among SB access. During the MEM stage, the SB that was granted access transfers data between its local storage and the SRAM array. Finally, during the WB stage, which only occurs on SRF reads, data from the SRAM array is written locally to the eight SB banks. While the SRF storage and control operates at half speed, the SBs operate at full speed, so the WB stage only takes one additional clock cycle to complete.

3.2.6 Streaming Memory System

The streaming memory system executes stream load and store instructions from the streamlevel ISA and supports up to two simultaneous instructions. The memory system is composed of two address generators (one for each instruction being executed), four memory banks, each with their own external DRAM interface (memory addresses are interleaved among the four banks), and a reordering streambuffer in the SRF. Rixner provides details on the memory bank and address generator microarchitecture [Rixner, 2001].

Four types of accesses are supported by the streaming memory system: sequential, strided, indexed, and bit-reversed. The address generators issue at most one word per cycle of memory read or write requests based on these access patterns to the appropriate memory banks. Within the memory banks, accesses are buffered, scheduled, and reordered by a memory controller in order to maximize utilization of the off-chip DRAM [Rixner *et al.*, 2000a]. While the latency of individual memory accesses could increase by this reordering, the overall latency of the stream load or store is reduced since memory bandwidth is improved with this technique. Since memory accesses are issued to the DRAM out of order, stream elements read during loads are reordered when they are written back into the streambuffer within the SRF to ensure proper ordering later during kernel execution.

3.2.7 Network Interface

The network interface on Imagine is used to connect the SRF to other Imagine chips in multiprocessor systems or to read or write from I/O devices. Stream send or receive instructions are used to transfer streams across the network using source routing. Four external network input channels and four output channels are supported. Each channel is able to transfer 2 bytes each clock cycle, for a total network bandwidth of 2 input words and 2 output words per cycle per node. This is matched to the total bandwidth supported by the network streambuffers.

Destinations and routes are written from the host processor into an entry in the Network Routing Register File. Since source routing is used, arbitrary network topologies with up to four physical channels per node are supported. One example of a supported topology would be a two-dimensional mesh network. Streams sent across the network are packaged into 64-bit flits and virtual channel flow control is used to manage communication across the network [Dally, 1992]. When the network interface receives a header flit into its ejection queue, it signals the stream controller to start an SRF transfer. As data flits are received, they are written two words at a time into one of the eight network streambuffers. A tail flit signals the end of the stream causing all remaining data flits in the streambuffer to be written to the SRF storage. Sending network streams work in a similar manner but in



Figure 3.9: Stream Controller Block Diagram

reverse with data being read from the streambuffers and packaged into flits as they are sent into the network interface injection queue.

3.2.8 Stream Controller

The above blocks from the Imagine processor execute instructions from the stream-level ISA. These instructions are issued by the host processor during the execution of stream programs. However, since the execution time of stream instructions is dynamically dependent on stream lengths, memory access patterns, and kernel code, dynamic scheduling of stream instructions is important in order to provide high utilization in both the memory system and arithmetic clusters. The stream controller handles this dynamic scheduling of stream instructions.

A block diagram of the stream controller is shown in Figure 3.9. Stream instructions sent by the host processor are written into one of the 32 entries in the operation buffer. Along with the instruction, the host processor sends bitmasks that specify dependencies between this instruction and the other 32 instructions currently in the operation buffer. This information is separated from the actual operation and is stored in the scoreboard. Meanwhile, a resource analyzer monitors status bits from the execution units and sends this information to the scoreboard as well. When a stream instruction's required resources

are free and its dependencies have been satisfied, it makes a request to an arbiter to be issued this cycle. One instruction is granted access and is sent from the operation buffer to the issue and decode logic. The issue and decode logic converts the instruction into control information that start the stream instruction in the individual execution units. A stream controller register file (SCTRF) is used to transfer scalar data such as stream lengths and scalar outputs from kernels if necessary. Once the stream instruction execution completes, its scoreboard entry is freed and subsequent instructions dependent on it can be issued.

By using dynamic scheduling of stream instructions, the stream controller ensures that stream execution units can stay highly utilized. This allows Imagine to exploit task-level parallelism by efficiently overlapping memory operations and kernel operations. Furthermore, the 32-entry operation buffer also allows the host processor to work ahead of the stream processor since the host can issue up to 32 stream instructions until it is forced to stall waiting for more scoreboard entries to be free. This buffering mitigates any effect the latency of sending stream instructions to the stream processor would have on performance.

3.3 Arithmetic Cluster Function Units

In this section, the design of the arithmetic cluster function units will be discussed. These function units execute the kernel-level instruction set from Table 3.1 and Table 3.2 and were developed with a number of design goals in mind, including low area, high throughput, low design complexity, low power, and low operation latency.

3.3.1 ALU Unit

Each cluster contains three ALU units that execute the addition, shift, and logical instructions listed in Table 3.1. Many of these instructions include support for floating-point, 32-bit integer, dual 16-bit, and quad 8-bit instructions. A block diagram of the ALU is shown in Figure 3.10. It is divided into three major functional sub-blocks, corresponding to pipeline stages in the execution of four-cycle operations. The ALU_X1 sub-block executes integer shifts, logical operations, and the alignment shift portion of floating-point additions. The ALU_X23 sub-block contains two pipeline stages and implements integer additions and the addition portion of floating-point adds. Rounding also occurs in the ALU_X23 stage during floating-point adds. Finally, the ALU_X4 sub-block executes a normalizing shift operation.

Operations requiring floating-point additions, such as FADD, FSUB, and others, are 4cycle operations and therefore use all three major sub-blocks. The ALU supports floatingpoint arithmetic adhering to the IEEE 754 standard, although only the round-to-nearesteven rounding mode and limited support for denormals and NaNs are supported [Coonen, 1980]. Additions supporting this standard can be implemented with an alignment shifter, a carry-select adder for summing the mantissas and doing the rounding, and a normalizing shifter [Goldberg, 2002; Kohn and Fu, 1989]. This basic architecture was used in the ALU unit.

Floating-point operands are comprised of a sign bit, eight bits for an exponent, and 23 bits for a fraction with an implied leading one. In the ALU_X1 block, a logarithmic shifter [Weste and Eshraghian, 1993] is used to shift the operand with the smaller exponent to the right by the difference between the two exponents. If the sign bits of the two operands are different, then the shifted result is also bitwise inverted, so that subtraction rather than addition will be computed in the ALU_X23 stage. Furthermore, both the unshifted and shifted fractions are then shifted to the left by two bits such that the leading one of the unshifted operand is at bit position 25 in the datapath (there are 32 bit positions numbering 0 to 31). This is necessary because guard, round, and sticky bits must also be added into the two operands in the ALU_X23 stage [Goldberg, 2002; Santoro *et al.*, 1989].

In the ALU_X23 stage, the shifted and unshifted operands are added together using a carry-select adder [Goldberg, 2002]. A block diagram of this adder is shown in Figure 3.11. For each byte in the result, the adder computes two additions in parallel, one assuming the carry-in to the byte was zero and the other assuming it was one. Meanwhile, a two-level tree computes the actual carry-ins to each byte. For integer additions, the carry-ins are based on the results of the group PGKs, the operation type, and the result sign bits. For floating-point adds, the carry-ins are based on the group PGKs and the overflow bit.

32-bit integer and lower-precision subword data-types also use the carry-select adder in



Figure 3.10: ALU Unit Block Diagram



Figure 3.11: Segmented Carry-Select Adder

the ALU_X23 stage to compute fast additions, subtractions and absolute difference computations. During these operations, the adder also computes two additions in parallel for each byte, but the global carry chain takes into account both the data-type and the operation being executed to determine whether the carry-in to each byte should be zero or one. Furthermore, when an subtraction occurs, the B operand must be inverted (not shown in the figure). Using this carry-select adder architecture, it was possible to design one adder that could be used for floating-point, 32-bit, 16-bit, and 8-bit additions and subtractions with little additional area or complexity over an adder that supports only integer additions.

3.3.2 MUL Unit

Like the ALU, the MUL unit also executes both floating-point and integer operations. A block diagram of the MUL unit is shown in Figure 3.12. There are two MUL units per cluster. Each unit has four pipeline stages and uses radix-4 booth encoding [Booth, 1951]. Since operands are up to 32 bits long, with radix-4 encoding, 16 partial products must be summed together. These partial products are summed using an architecture based around two half arrays [Kapadia *et al.*, 1995] followed by a 7:2 combiner.

In the first pipeline stage, the multiplier operand is analyzed by the booth encoder and



Figure 3.12: MUL Unit Block Diagram

control information is sent to the two half arrays. Based on this control information, each partial product contains a shifted version of -2, -1, 0, 1, or 2 times the multiplicand, which can easily be computed with a few logic gates per bit and a 1-bit shifter within the half arrays. Once the partial products have been computed, each half array sums eight of the partial products with 6 rows of full adders. The first row combines 3 of the partial products and each of the other 5 rows add in one more partial product. Three of these additions occur in the X1 pipeline stage and the other three occur in the X2 stage.

Once the half arrays have summed the 8 products, each half array sends two 48-bit outputs to a 7:2 combiner. This combiner sums these four values with three other buses from the sign extension and two's complement logic. These three buses ensure a correctly sign extended result and also add a one into the lsb location of partial products that were -2 or -1 times the multiplicand during booth encoding. To keep the half arrays modular and simple, this occurs here rather than in the half arrays. The 7:2 combiner is implemented with 5 full adders: three of the adders are in the X2 stage and two are in the X3 stage. The 7:2 combiner outputs two 64-bit buses that are converted back into non-redundant form with a 64-bit carry-select adder. Its architecture is similar to the 32-bit integer adder shown in Figure 3.11, but is extended to 64 bits. The adder spans two pipeline stages: the actual additions and carry propagation occurs in X3 while the carry select and final multiplexing occurs in X4. This result is then analyzed and sent through muxes which handle alignment shifting during floating-point operations and saturation during some integer operations before it is buffered and broadcast across the intracluster switch.

Like the ALU unit, the MUL unit is also designed to execute 16-bit, 32-bit, and floatingpoint additions. 8-bit multiplications were not implemented to reduce design complexity. During floating-point or 32-bit multiplications, the multiplier operates as described above. However, during 16-bit multiplications, some parts of the multiplier half array must be disabled, otherwise partial products from the upper half-word would be added into the result from the lower half-word and vice versa. To avoid this problem, a mode bit is sent to both half arrays so that during 16-bit operation, the upper 16 bits of the multiplicand are set to zero in the lower half array and the lower 16 bits of the multiplicand are set to zero in the upper half array. Although lower-latency 16-bit multiplications could be achieved by summing less partial products together, this optimization was not made in order to minimize



Figure 3.13: DSQ Unit Block Diagram

unnecessary design complexity and wiring congestion.

3.3.3 DSQ Unit

The DSQ unit supports floating-point divide and square root operations, as well as integer divide and remainder functions. Its block diagram is shown in Figure 3.13 and is based around a radix-4 SRT iterative divide algorithm [Goldberg, 2002]. The DSQ unit is split into four parts: a pre-processor, two cores, and a post-processor. In the pre-processor, operands are converted to internal formats used by the core, requiring 1 cycle for floating-point operations and 2 cycles for integer operations. These results are then passed to one of two cores, which takes 13 to 17 cycles depending on the operation and the data-type to execute the iterative SRT algorithm. Each cycle, the core processes 2 bits of the operands starting with the most significant bits, and continues to iterate until it has processed the least significant bits. Its output is sent in carry-save redundant form to the post-processor which performs several additions in order to compute the final quotient². Unlike the ALU and

²An alignment shift is also required when computing the remainder is necessary.

MUL units, the DSQ is not fully pipelined, but more than one operation can be executed concurrently because once an operation has passed through the pre-processor and into one of the cores, a new operation can be issued and executed in the other core as long as the operations will not conflict in the post-processor stage.

3.3.4 SP Unit

While the ALU, MUL, and DSQ units support all of the arithmetic operations in a cluster, several important non-arithmetic operations are supported by the SP, COMM, and JB/VAL units. The scratchpad (SP) unit provides a small indexable memory within the clusters. This 256-word memory contains one read port and one write port and supports base plus index addressing, where the base is specified in the VLIW instruction word and the index comes from a local LRF. This allows small table lookups to occur in each cluster without using LRF storage or sacrificing SRF bandwidth.

3.3.5 COMM Unit

The next non-arithmetic function unit is the COMM unit. It is used to exchange data between the clusters when kernels are not completely data parallel. The COMM unit is implemented with 9 32-bit repeatered buses that transmit data broadcast from all eight clusters and the microcontroller. Each cluster COMM unit then contains a 9:1 multiplexer which selects which of these buses should be selected and output across the intracluster switch.

3.3.6 JB/VAL Unit

The last cluster function unit is the JB/VAL unit. It is used in coordination with the SP and COMM units to execute conditional streams [Kapasi *et al.*, 2000]. During the execution of conditional input or output streams, condition codes in each cluster specify whether that cluster should execute a conditional input or output on this loop iteration. The COMM unit is used to route data between clusters so that a cluster requesting the next element of a conditional stream will read or write from the correct streambuffer bank. The SP unit is

	Clusters								
	7	6	5	4	3	2	1	0	
Loop Iteration 1									
Condition codes	0	1	1	0	1	1	1	0	
COMM source cluster	Χ	Х	Х	6	5	3	2	1	
Next cluster pointer 5									
Ready bit	0								
Loop Iteration 2									
Condition codes	1	0	0	1	1	0	1	0	
COMM source cluster	4	3	1	Х	Х	Х	Х	7	
Next cluster pointer		1							
Ready bit	1								
Loop Iteration 3									
Condition codes	0	0	0	0	0	1	0	1	
COMM source cluster	Χ	Х	Х	Х	Х	2	0	Х	
Next cluster pointer	3								
Ready bit	0								

Table 3.3: JB/VAL Operation for Conditional Output Streams

used as a double buffer in order to stage data between the streambuffers and the COMM unit. Finally, the JB/VAL functional unit manages the control wires that are sent to the streambuffers, the COMM unit, and the SP unit in each cluster during conditional streams.

To explain the operation of conditional output streams, consider the example shown in Table 3.3. In this example, single-word records are assumed, so there are five instructions involved with each conditional output stream during each loop iteration: GEN_COSTATE, COMM, SPCWR, SPCRD, and COND_OUT_D. During the first iteration through the loop, condition codes specify that only five clusters have valid data to send to the output stream. In each cluster, the GEN_COSTATE instruction in the JB/VAL unit reads these condition codes and computes a COMM source cluster, a next cluster pointer, and a ready bit (the values for the next cluster pointer and the ready bit are the same across all eight clusters). In this case, the five clusters with valid data (clusters 1, 2, 3, 5, and 6) will send their data to the first five clusters (0 through 4). When the COMM is executed, each cluster uses its

COMM source cluster value to read the appropriate data from the intercluster switch and buffers this data locally in its scratchpad using SPCWR. The next cluster pointer keeps track of where the next valid element should be written during subsequent loop iterations. The ready bit keeps track of whether eight new valid elements have been accumulated and should be written to the output streambuffer from the scratchpad. During the first loop iteration, since only five valid elements have been stored in the scratchpad, the next cluster pointer is set to 5 and the ready bit is set to zero. When the SPCRD and COND_OUT_D are executed this loop iteration, the write to the streambuffer is squashed because the ready bit was set to zero.

During the second iteration, four clusters have valid data. In this case, when the JB/VAL unit executes GEN_COSTATE, it uses the next cluster pointer (set to 5 by the previous iteration) and new condition codes to compute the source clusters to be used during the COMM. Again, the data is buffered locally in the scratchpad with SPCWR. However, this time since eight valid elements have been accumulated across the clusters (five from the first iteration and three from the second), the ready bit is set to one. When the COND_OUT_D instruction is executed, these eight values stored in the scratchpad are written to the output streambuffer. Double buffering is used in the scratchpad so that the values written into cluster 0 during the first two iterations do not conflict. The third and final iteration in the example contains only two valid elements from clusters 0 and 2, and in this case, those elements are written into clusters 1 and 2.

Subsequent iterations continue in a similar manner, with the JB/VAL unit providing the control information for the streambuffers, COMM unit, and SP unit. Figure 3.14 shows the circuit used in the JB/VAL unit to compute the COMM source cluster. Each cluster computes this by subtracting the next cluster pointer from its cluster number, then using that difference to select one of the source clusters with a valid CC. For example, if the difference were three, then this cluster is looking for the third cluster starting from cluster 0 with a CC set to 1. The selection occurs by converting the 3-bit difference into a one-hot 8-bit value, then using each CC to conditionally shift this one-hot value by one position. Once enough valid CCs have been encountered, the lone one in the one-hot value will have been shifted off the end. Since only one row will shift a one off the end, the COMM source index can be easily computed by encoding the bits shifted off the end back into



Figure 3.14: Computing the COMM Source Index in the JB/VAL unit

Unit	Quantity	Area	Area	Standard	Cell Area
		(mm^2)	(grids)	Cells	(NAND2s)
16-word LRF	176	0.046	116K	1197	4356
CCRF	64	0.042	106K	1168	2687
ALU	24	0.329	829K	10079	20955
MUL	16	0.486	1224K	10741	33755
DSQ	8	0.455	1146K	12953	34390
SP	8	0.393	990K	N/A	N/A
Cluster Crossbar	8	0.566	1426K	4572	31078
COMM Switch	1	1.805	4548K	39456	240536
SB Bank	176	0.110	277K	1160	5262
SRF Bank	8	0.835	2104K	N/A	N/A
Microcode Store	1	7.149	18012K	N/A	N/A

Table 3.4: Function Unit Area and Complexity

a 3-bit value. The computations required for the next cluster pointer and ready bit are not shown in Figure 3.14, but they can be computed by simply adding the eight 1-bit CC values together.

In addition to computing the COMM source index, next cluster pointer, and ready bit, the JB/VAL unit also keeps track of when the stream ends. This is necessary for padding streams when the total number of valid elements in a conditional stream is not a multiple of the number of clusters. Conditional input streams function similarly to conditional output streams, except buffering in the scratchpad occurs before traversing the intercluster switch rather than vice versa.

3.4 Summary

The six function units described above along with the LRFs, CCRFs, and intracluster switch are the components of an arithmetic cluster on the Imagine stream processor. The main design goals for these arithmetic units were low design complexity, low area, high throughput, and low power. Although latency was important to keep limited to a reasonable value, it

was not a primary design goal. As described in the next chapter, these arithmetic cluster components were implemented in a standard cell CMOS technology with 0.15 micron drawn gate length transistors and five layers of Aluminum with metal spacing typical to a 0.18 micron process. For a number of these arithmetic units and other key compoments, Table 3.4 shows their silicon area (both in mm^2 and in wire grids³), number of standard cells, and total standard cell area if additional area required for wiring between standard cells is discounted(normalized to the area of a NAND2 standard cell).

In summary, the ISA, microarchitecture, and functional unit circuits from the Imagine stream processor are designed for directly executing the stream programs in an area- and energy-efficient manner. The next two chapters will describe the design methodology and performance efficiency results achieved when this microarchitecture was implemented in modern VLSI technology.

 $^{{}^{3}}$ A wire grid in this process is 0.40 square microns

Chapter 4

Imagine: Design Methodology

To demonstrate the applicability of the Imagine stream processor to modern VLSI technology, a prototype Imagine processor was designed by a collaboration between Stanford University and Texas Instruments (TI). Stanford completed the microarchitecture specification, logic design, logic verification, and did the floorplanning and cell placement. TI completed the layout and layout verification. Imagine was implemented in a standard cell CMOS technology with 0.15 micron drawn gate length transistors and five layers of Aluminum with metal spacing typical to a 0.18 micron process.

The key challenge with the VLSI implementation of Imagine was working with the limited resources afforded by a small team of less than five graduate students, yet without sacrificing performance. In total, the final Imagine design included 701,000 unique placeable instances and had an operating frequency of 45 fan-out-of-4 inverter delays, as reported by static timing analysis tools. This was accomplished with a total design effort of 11 person-years on logic design, floorplanning and placement, significantly smaller than the design effort typical to comparable industrial designs [Malachowsky, 2002].

This chapter provides an overview of the design process and experiences for the Imagine processor. Section 4.1 presents the design schedule for Imagine followed by background on the standard-cell design methodologies typically used for large digital VLSI circuits in Section 4.2. Section 4.3 introduces a *tiled region* design methodology, the approach used for Imagine, where the designer is given fine-grained control over placement of small regions of standard cells in a datapath style. Finally, the clocking and verification methodologies used for Imagine are presented.

4.1 Schedule

By summer 1998, the Imagine architecture specification had been defined and a cycleaccurate C++ simulator for Imagine was completed and running. In November 1998, logic design had begun with one Stanford graduate student writing the RTL for an ALU cluster. By December 2000, the team working on Imagine implementation had grown to five graduate students and the entire behavioral RTL model for Imagine had been completed and functionally verified.

The Imagine floorplanning, placement, and layout was carried out by splitting the design into five unique *subchips* and one top-level design. In November 2000, the first trial placement of one of these subchips, an ALU cluster, was completed by Stanford. By August 2001, the final placement of all five subchips and the full-chip design was complete and Stanford handed the design off to TI for layout and layout verification. In total, between November 1998 when behavioral RTL was started and August 2001 when the placed design was handed off to TI, Stanford expended 11 person-years of work on the logic design, floorplanning, and placement of the Imagine processor. Imagine parts entered a TI fab in February 2002. First silicon was received in April, 2002 and full functionality was verified in the laboratory in subsequent months.

4.2 Design Methodology Background

Typically, with a small design team, an *ASIC* design methodology is used. This is in contrast to a full-custom design methodology, which is used for more aggressive designs targeting higher clock rates. Although there can be a greater than a factor-of-3 difference in both area and performance between custom and ASIC designs [Dally and Chang, 2000] [Chinnery and Keutzer, 2000] [Chang, 1998], with the small size of the Stanford design team, using a full-custom design methodology was not possible. Hence, logic design was restricted to using gates and register elements from a standard-cell library.



Figure 4.1: Standard ASIC Design Methodology

Figure 4.1 shows the typical ASIC tool flow. RTL is written in a hardware description language such as Verilog and is mapped to a standard-cell library with a logic synthesis tool such as Synopsys Design Compiler [Synopsys, 2000a]. Wire lengths are estimated from statistical models and timing violations are fixed by resynthesizing with new timing constraints or by restructuring the logic. After pre-placement timing convergence, designs are then passed through an automatic place and route tool, which usually uses a timing-driven placement algorithm. After placement, wire lengths from the placed design are extracted and back-annotated to a static timing analysis (STA) tool. However, when actual wire lengths do not match predicted pre-placement statistical-based wire lengths, this can cause a timing problem and can lead to costly design iterations, shown in the bottom feedback loop.

Recent work in industry and academia has addressed many of the inefficiencies in ASIC flows. This work can be grouped in two categories: improving timing convergence and incorporating datapath-style design in ASIC flows.

Physically-aware synthesis approaches [Synopsys, 2000b] attempt to address the shortcomings of timing convergence in traditional flows by concurrently optimizing the logical and physical design, rather than relying on statistically-based wire-length models. The principal benefit of these techniques is to reduce the number of iterations required for timing convergence, and as a result, deliver modest improvement in timing performance and area.

Datapaths are examples of key design structures that ASIC flows handle poorly. There are three limitations. First, aggregating many simple standard cells to create a complex
function is inefficient. Second, the typical logical partitions (functional) often differ from the desirable physical partitions (bit-slices). Finally, since the "correct" bit-sliced datapath solution is very constrained, small errors in placement and routing during automated optimization can result in spiraling congestion and can quickly destroy the inherent regularity. When developing the design methodology for Imagine, the goal was to keep the inherent advantages of standard-cell design, but to eliminate some of the inefficiencies of ASIC methodologies by retaining datapath structure.

Many researchers have demonstrated that identifying and exploiting regularity yields significant improvements in density and performance for datapath structures in comparison to standard ASIC place and route results [Chinnery and Keutzer, 2002]. In particular, researchers have shown numerous automated techniques for extracting datapath structures from synthesized designs and doing datapath-style placement [Kutzschebauch and Stok, 2000] [Nijssen and van Eijk, 1997] [Chowdhary *et al.*, 1999]. However, widespread adoption of these techniques into industry-standard tools had not yet occurred by the time the VLSI design for the Imagine processor was started.

4.3 Imagine Design Methodology

Given the small size of the Stanford design team and the need to interface with industrystandard tools, the design methodology for Imagine was constrained to use the basic tool flow shown in Figure 4.1. However, a large percentage of logic from Imagine are structured arrays and arithmetic units that could benefit from datapath-style placement. To take advantage of this datapath regularity and to expedite timing convergence, this tool flow was modified. Physical-aware synthesis techniques were not available while the VLSI design was carried out, so a *tiled region* design methodology was used. This methodology provides similar advantages in gate density to the techniques presented in Section 4.2 for doing datapath-style design in a standard cell technology.

The total Imagine design contains 1.78 million standard cells. However, many of these standard cells are parts of large blocks which are repeated many times, such as arithmetic units or register files. In order to leverage this modularity, and to reduce the maximum design size handled by the CAD tools, the Imagine design was partitioned into five *subchips*

	Instances	Gate Area	#
CLUST	130,000	304K	8
UC	27,000	27K	1
SRF	314,000	1.31M	1
HISCNI	98,000	320K	1
MBANK	57,000	169K	4
Top Level	75,000	351K	1
Full Chip	701,000	5.12M	1

Table 4.1: Subchip statistics

and one top-level design. In the ASIC methodology used on Imagine, *flat placement* within a subchip is used, where all of the standard cells in each subchip are placed at once. This is in contrast to hierarchical placement techniques where subcomponents of a subchip are placed first and larger designs are built from smaller sub-designs. After routing each subchip, the top-level design then includes instances of the placed and routed subchips as well as additional standard cells. Table 4.1 shows the number of instances, area, and gate area in equivalent NAND2 gates for each of the five subchips: the ALU cluster (CLUST), the micro-controller (UC), the stream register file (SRF), the host interface / stream controller / network interface (HISCNI), and the memory bank (MBANK). Each of these subchips corresponds directly to units in Figure 2.3 except the MBANK. The streaming memory system is composed of 4 MBANK units: 1 per SDRAM channel. Also shown is the top-level design, which includes glue logic between subchips and I/O interfaces.

In addition to the gates listed in Table 4.1, some of the subchips also contain SRAM's instantiated from the TI ASIC library. The UC contains storage for 2048 576-bit VLIW instructions organized as 9 banks of single-ported, 1024-word, 128-bit SRAM's. The SRF contains 128 KBytes of storage for stream data, organized as 8 banks of single-ported, 1024-word, 128-bit SRAM's. There is a dual-ported, 256-word, 32-bit SRAM in each ALU cluster for scratchpad memory. Finally, the HISCNI subchip contains SRAM's for input buffers in the network interface and for stream instruction storage in the stream controller.

Several of the subchips listed above benefit from using datapath-style design. Specifically, each ALU cluster contains six 32-bit floating-point arithmetic units and fifteen 32-bit



Figure 4.2: Tiled Region Design Methodology

register files. Exploiting the datapath regularity for these units keeps wire lengths *within* a bitslice very short, which in turn leads to smaller buffers, and therefore a more compact design. In addition, control wires are distributed *across* a bitslice very efficiently since cells controlled by the same control wires can be optimally aligned. The SRF, which contains 22 8-entry 256-bit streambuffers, also benefits from the use of datapaths. The 256 bits in the streambuffers align to the 8 clusters' 32-bit-wide datapath, keeping wires predictable and short and allowing for efficient distribution of control wires.

The tiled-region basic flow used on Imagine is shown in Figure 4.2. It is similar to the typical ASIC methodology shown previously in Figure 4.1. However, several key additional steps, shown in gray, have been added in order to allow for datapath-style placement and to reduce costly design iterations. First, in order to make sure that datapath structure is maintained all the way through the flow, two RTL models were used. A second RTL model, labeled *structured RTL*, was written. It is logically equivalent to the behavioral RTL, but contains additional logical hierarchy in the RTL model. Datapath units such as adders, multipliers, and register files contain submodules that correspond to datapath bit-slices. These bitslices correspond to a physical location along the datapath called a region. Regions provide a hard boundary during placement, meaning cells assigned to that region will only be placed within the associated datapath bitslice. Regions are often used in typical

ASIC design methodologies in order to provide constraints on automatic place and route tools, but the tiled-region flow has a much larger number of smaller regions (typically 10 to 50 instances per region) when compared to timing-driven placement flows.

In addition to the floorplanning of regions, the subchip designer also must take into account the *wire plan* for a subchip. The wire plan involves manually annotating all wires of length greater than one millimeter with an estimated capacitance and resistance based on wire length between regions. By using these manual wire-length annotations during synthesis and timing analysis runs, statistical wire models generated during synthesis are restricted to short wires. Manual buffers and repeaters were also inserted in the structured RTL for long wires. With wire planning, pre-placement timing more closely matches post-placement timing with annotated wire resistance and capacitance.

A more detailed view of the floorplanning and placement portion of the tiled-region methodology is shown in Figure 4.3. Consider an 8-bit adder. It would be modeled with the statement y = a + b in behavioral RTL. However, the structured RTL is split up by hand into bitslices as shown in Figure 4.3. The structured RTL is then either mapped by hand or synthesized into a standard-cell netlist using Synopsys Design Compiler [Synopsys, 2000a].

In conjunction with the netlist generation, before placement can be run, floorplanning has to be completed. In the tiled-region design methodology, this is done by writing a *tile file*. An example tile file containing two 8-bit adders is shown in the upper right of Figure 4.3. The tile file contains a mapping between logical hierarchy in the standard cell netlist and a bounding box on the datapath given in x-y coordinates. The example tile file shows how the eight bitslices in each adder would be tiled if the height of each bitslice was 30 units. Arbitrary levels of hierarchy are allowed in a tile file, allowing one to take advantage of modularity in a design when creating the floorplan. In this example, two levels of hierarchy are used, so cells belonging to the *adder_1/slice5* region would be placed in the bounding box given by 40 < x < 80 and 150 < y < 180.

Once the floorplan has been completed using a tile file, it is then passed through a tool developed by Stanford called *tileparse*. Tileparse flattens the hierarchy of the tile file and outputs scripts which are later run by the placer to set up the regions. Once the regions have been set up, but before running placement, the designer can look at the number of



Figure 4.3: Tiled Region Floorplanning Details

	Occ	mm^2	# Regions	Placement
CLUST	65.1%	5.1 imes 0.8	1,556	Tiled-Region
UC	56.3%	6.2×1.4	102	Tiled-Region
SRF	54.5%	9.0×4.0	6,640	Tiled-Region
HI/SC/NI	38.9%	8.0 imes 1.4	237	Tiled-Region
MBANK	69.1%	1.2×1.8	15	Timing-Driven
Top Level	63.3%	N/A	1,095	Tiled-Region

Table 4.2: Imagine placement results

cells in a region and iterate by changing region sizes and shapes until a floorplan that fits is found. Finally, the Avant! Apollo-II automatic placement and global route tool [Chen, 1999] is used to generate a trial placement on the whole subchip. These steps are then iterated until a floorplan and placement with satisfactory wiring congestion and timing has been achieved. The steps following placement in the tiled-region design methodology do not differ from the typical ASIC design methodology.

4.4 Imagine Implementation Results

Table 4.2 shows the placement results for the subchips and top level design. Standard cell occupancy is given as a ratio of standard cell area to placeable area. Area devoted to large power buses or SRAMs is not considered placeable area. Tiled-region placement was used on all of the subchips except for the smaller MBANK subchip, which did not have logic conducive to datapath-style placement. It is important to note that occupancy is most dependent on the characteristics of the subchip such as overall wire utilization and floorplan considerations. For example, high wiring congestion contributed to the lower occupancies of the HISCNI subchip and low wiring congestion allowed for high occupancies in the MBANK subchip. The SRF has regions of low occupancy for interfacing with the SRAM's and other subchips that reduce its overall occupancy. However, in regions where large numbers of datapaths, occupancy was over 80%.

By using tiled-regioning, large subchips such as the SRF and CLST with logic conducive to datapath-style placement were easily managed by the designer. For example, placement runs for the SRF, which contained over 300,000 instances took only around one hour on a 450 MHz Ultrasparc II processor. This meant that when using tiled-region placement on these large subchips, design iterations proceeded very quickly. Furthermore, the designer had fine-grained control over the placement of regions to easily fix wiring congestion problems. For example, the size and aspect ratio of datapath bitslices could be modified as necessary to provide adequate wiring resources.

Timing results for each of these subchips are included in Table 4.3. Maximum clock frequency and critical path for each clock domain in fan-out-of-4 inverter delays (FO4s) are shown. Results were measured using standard RC extraction and STA tools at the typical process corner.

4.5 Imagine Clocking Methodology

Most ASIC's use a tree-based clock distribution scheme. This approach was also used on Imagine, but distributing a high-speed clock with a large die size and many clock loads with low skew was challenging. Typical high-performance custom designs use latch-based design to enable skew tolerance and time-borrowing. However, a large variety of highperformance latches were not available in Imagine's standard cell library, so an edgetriggered clocking scheme where clock skew affects maximum operating frequency was used. Latches, instead of flip-flops, were used in some register file structures in the ALU clusters in order to reduce area and power dissipation.

In order to distribute a clock to loads in several subchips while minimizing skew between the loads, the standard flow in the TI-ASIC methodology was used. First, after each subchip was placed, a clock tree was expanded within each subchip using available locations in the floorplan to place clock buffers and wires. Skew between the clock loads was minimized using Avant! Apollo [Chen, 1999]. Later, when all of the subchips were instantiated in the full-chip design, delay elements were inserted in front of the clock pins for the subchips so that the insertion delay from the inputs of the delay elements to all of the final clock loads would be matched for the average insertion delay case. Next, the same flow

Clock	Max Freq	T_{cycle} (FO4s)	Clock Loads
iclk	296 MHz	46.3	160K
sclk	148 MHz	92.6	8.8K
hclk	175 MHz	78.3	2.7K
mclk	233 MHz	58.6	19K
nclkin	296 MHz	46.3	166
nclkout	296 MHz	46.3	55

Table 4.3: Imagine timing results

used on the subchips was used to synthesize a balanced clock tree to all of the inputs of the delay elements and the leaf-level clock loads for clocked elements in the top-level design.

Imagine must interface with several different types of I/O each running at different clock speeds. For example, the memory controller portion of each MBANK runs at the SDRAM clock speed. Rather than coupling the SDRAM clock speed to an integer multiple of the Imagine core clock speed, completely separate clock trees running at arbitrarily different frequencies were used. In total, Imagine has 11 clock domains: the core clock (iclk), a clock running at half the core clock speed (sclk), the memory controller clock (mclk), the host interface clock (hclk), four network input channel clocks (nclkin_n, nclkin_s, nclkin_e, nclkin_w), and four network output channel clocks (nclkin_n, nclkout_s, nclkout_e, nclkout_w). These clocks and the loads for each clock are shown in Table 4.3, but for clarity, only one of the network channel clocks is shown. The maximum speed of the network clocks were architecturally constrained to be the same speed as iclk, but can operate slower if needed in certain systems. Mclk and hclk are also constrained by the frequency of other chips in the system such as SDRAM chips, rather than the speed of the logic on Imagine. Sclk was used to run the SRF and stream controller at half the iclk speed. The relaxed timing constraints significantly reduced the design effort in those blocks and architectural experiments showed that running these units at half-speed would have little impact on overall performance.

The decoupling provided by Imagine's 11 independent clock domains reduces the complexity of the clock distribution problem. Also, non-critical timing violations within one clock domain can be waived without affecting performance of the others. To facilitate these



Figure 4.4: Asynchronous FIFO Synchronizer

many clock domains, a synchronizing FIFO was used to pass data back and forth between different clock domains. Figure 4.4 shows the FIFO design used [Dally and Poulton, 1998]. In this design, synchronization delay is only propagated to the external inputs and outputs when going from the full to non-full state or vice versa, and similarly with the empty to non-empty state. Brute force synchronizers were used to do the synchronization. By making the number of entries in the FIFO large enough, write and read bandwidths are not affected by the FIFO design.

4.6 Imagine Verification Methodology

Functional verification of the Imagine processor was a challenge given the limited resources available in a university research group. A functional verification test suite was written and run on the behavioral RTL. The same test suite was subsequently run on the structured RTL. Tests in the suite were categorized either as module-level or chip-level tests. Standard industry tools performed RTL-to-netlist and netlist-to-netlist comparisons for functional equivalency using formal methods.

Module-level tests exercised individual modules in isolation. These tests were used on modules where functionality was well-defined and did not rely on large amounts of complex control interaction with other modules. Module-level tests that exercised specific corner cases were used for testing Imagine's floating-point adder, multiplier, divide-squareroot (DSQ) unit, memory controller, and network interface. In each of these units, significant random testing was also used. For example, in the memory controller, large sequences of random memory reads and writes were issued. In addition, square-root functionality in the DSQ unit was tested exhaustively.

Chip-level tests were used to target modules whose control was highly coupled to other parts of the chip and for running portions of real applications. Rather than relying only on end-to-end correctness comparisons in these chip-level tests, a more aggressive comparison methodology was used for these tests. A cycle-accurate C++ simulator had already been written for Imagine. During chip-level tests, a comparison checker verified that the identical writes had occurred to architecturally-visible registers and memory in both the C++ simulator and the RTL model. This technique was very useful due to the large number of architecturally-visible registers on Imagine. Also, since this comparison occurred every cycle, it simplified debugging since any bugs would be seen immediately as a register-write mismatch. A number of chip-level tests were written to target modules such as the stream register file and microcontroller. In order to generate additional test coverage, insertion of random stalls and timing perturbations of some of the control signals were included in nightly regression runs.

In total, there were 24 focused tests, 10 random tests, and 11 application portions run nightly as part of a regression suite. Some focused tests included random timing perturbations. Every night 0.7 million cycles of focused tests, 3.6 million cycles of random tests, and 1.3 million cycles of application portions were run as part of the functional verification test suite on the C++ simulator, the behavioral RTL and the structured RTL. These three simulators ran at 600, 75, and 3 Imagine cycles per second respectively when simulated on a 750 MHz UltrasparcIII processor.

In summary, the design, clocking, and verification methodologies used on Imagine enabled the design of a 0.7M-instance ASIC without sacrificing performance, and with a considerably smaller design team than comparable industrial designs.

Chapter 5

Imagine: Experimental Results

In this chapter, experimental results measured from the Imagine stream processor are presented. Imagine was fabricated in a Texas Instruments CMOS process with metal spacing typical to a 0.18 micron process and with 0.15 micron drawn-gate-length transistors.

Figure 5.1 shows a die photograph of the Imagine processor with the five subchips presented in Chapter 4 highlighted. Its die size is $16 \text{ mm} \times 16 \text{ mm}$. The IO's are peripherally bonded in a 792-pin BGA package. There are 456 signal pins (140 network, 233 memory system, 45 host, 38 core clock and debug), 333 power pins (136 1.5V-core, 158 3.3V-IO, 39 1.5V-IO), and 3 voltage reference pins. The additional empty area in the chip plot is either glue logic and buffers between subchips or is devoted to power distribution.

5.1 Operating Frequency

The operating frequency for Imagine was tested on a variety of applications and a range of core supply voltages. As presented in Chapter 4, static timing analysis tools predicted Imagine to be fully functional with a clock period of 46 fan-out-of-4 inverter delays, corresponding to 296 MHz operation at the typical process corner at 1.5V and 25°C. (188 MHz at the slow process corner, 1.35V, and 125°C). As shown in Figure 5.2, laboratory measurements for the Imagine processor show significantly slower operation, with a maximum clock speed of 288 MHz at 2.1V, and a clock speed of only 132 MHz at 1.5V. Package temperature was monitored during these measurements, and stayed under 40°C with the



Figure 5.1: Die Photograph



Figure 5.2: Measured Operating Frequency

aid of a heat sink and air cooling provided by a fan.

At 288 MHz, Imagine provides a peak performance of 11.5 GFLOPS or 23 16-bit GOPS, and is able to sustain over 60% of peak performance on some key media processing applications. However, at 1.5V operation, its clock speed of 132 MHz is less than half as fast as the 296 MHz typical-corner operation and 30% slower than the slow-corner operation predicted by static timing analysis tools. Further analysis provides insight into the source of this discrepancy between predicted and measured performance.

Process variation in both transistors and metal interconnect causes some of the discrepancy. While in an idle state with clocks disabled, an on-chip ring oscillator located near the periphery of the Imagine die had a measured frequency of 3.13 MHz at 1.5V. In contrast, timing analysis tools predicted a frequency of 3.48 MHz at the typical process corner and 1.5 V. Since power supply noise and IR drop to the ring oscillator during this measurement would be negligible, this difference suggests there is a frequency degradation of 11% due solely to process variation in the transistors themselves. However, process variation in the resistance of metal interconnect and via layers can also exist in modern technology. This variation is more difficult to measure, but variation in these parameters could also contribute to a small amount of additional performance degradation.



Figure 5.3: Measured Ring Delay

Further insight into reasons for a lower-than-predicted operating frequency can be provided by comparing the voltage dependence of Imagine's cycle time to the voltage dependence of the ring oscillator delay. This data is graphed in Figure 5.3. The scaled ring oscillator delay, shown in the curve on the left, is the ring oscillator delay multiplied by a constant factor, so that at 1.5 Volts, it equals 3.79ns (for a frequency of 264 MHz). This delay is what would be expected from static timing analysis given the 11% performance degradation due to process variation measured on the ring oscillator. Therefore, the scaled ring oscillator delay shows the cycle time predicted by static timing analysis across a range of supply voltages.

As other researchers have shown [Chen *et al.*, 1997], the effect supply voltage has on gate delay in modern CMOS processes where transistors are typically velocity saturated can be modeled by:

$$t_d = kC \frac{V}{(V - V_{th})^{1.25}}$$
(5.1)

The measured delay through the ring oscillator follows this gate delay model closely if a threshold voltage, V_{th} , of 0.38 Volts is assumed.

On the other hand, the measured cycle time, shown in the curve on the right in Figure 5.3, shows voltage adversely affecting delay at significantly higher voltages and in fact, Imagine stops functioning correctly below 1.2 Volts. At 1.5 Volts, the actual cycle time is twice the delay predicted by the scaled ring oscillator delay. However, this relative difference is greater for lower voltages and smaller for higher voltages. For example, at 1.2 Volts, the difference is 3x and at 2.0 Volts, the difference is 1.28x.

Several factors could explain the discrepancies between predicted and measured cycle times. First, internal IR drop across large wire resistances in the the core power supply could contribute to significantly lower voltages at standard cells located on critical paths. In addition, if IR drop led to low supply voltages for gates with feedback elements or circuits that have delays not accurately modeled by (5.1), then their performance at low voltages could be degraded more severely than the ring oscillator, and they could even stop functioning correctly. Finally, the lack of sufficient bypass capacitance on the power supply in areas of the chip with highly varying current draw could lead to additional supply degradation not modeled by IR drop and could further degrade performance. These factors could explain the measured cycle time's steep slope at voltages significantly higher than that predicted by the ring oscillator delay measurements. Unfortunately, without sophisticated measurement techniques, it is difficult to conclusively verify the exact factors contributing to this behavior. Nevertheless, if thorough analysis and careful re-design of the on-chip power distribution network were able to solve the discrepancy between predicted and measured operating frequency, at worst-case operating conditions a 1.42x performance improvement without increasing voltage or degrading energy efficiency would be observed. By improving to typical operating conditions, a 2x performance improvement over current behavior would be achieved.

5.2 **Power Dissipation**

In addition to performance, a processor's power dissipation is a very important characteristic in many media processing systems. Figure 5.4 shows Imagine's core total power dissipation as the core power supply is varied from 1.2 to 2.1 Volts, assuming operating



Figure 5.4: Measured Core Power Dissipation

frequencies from Figure 5.2. The core power dissipation was measured during a test application written to keep Imagine fully occupied with floating-point arithmetic instructions. Imagine's power dissipation is dominated by dynamic power dissipation, given by:

$$P = C_{sw}V^2f$$

where C_{sw} is the average capacitance switched per clock cycle. At 1.5 Volts and 132 MHz, a power dissipation of 3.07 Watts was observed, meaning that C_{sw} , the average capacitance switched per clock cycle, was measured to be 10.3 nF.

Although it is difficult to determine exactly how this 10.3 nF of C_{sw} is distributed throughout Imagine, estimates can be made with Synopsys Design Compiler [Synopsys, 2000a] using exact capacitances and resistances extracted from actual layout and toggle rates captured from a test application. These estimates are presented in the pie chart in Figure 5.5 and sum to the 10.3 nF measured experimentally. Total power dissipation is separated into three major categories: clock, arithmetic clusters, and other. Clock power includes capacitance switched during idle operation when only the Imagine core clock is toggling, and is further subdivided into three categories: C_{sw} in the clock tree, C_{sw} in the loads of the clock tree, and C_{sw} internally within the flip flops. Together, clock power



Figure 5.5: C_{sw} distribution during Active Operation

comprises around 55% of the total core power, verified experimentally by idle power measurements. The arithmetic cluster power is also subdivided into two categories: capacitance switched in the ALUs and capacitance switched elsewhere in the cluster such as in the LRFs and intracluster switch. The final remaining category labeled SRF, UC, and Mbanks includes the switched capacitance not accounted for in the arithmetic clusters or clock network.

Note that on Imagine, a large percentage of power dissipation is devoted to arithmetic units. Not only is 20% of active power dissipated in the ALUs, but over one third of the internal flip flop clock power and clock load power is in pipeline registers within the ALUs. In total, nearly 40% of the chip power is spent directly on providing high-bandwidth arithmetic units. Furthermore, power dissipation could be significantly reduced by lowering clock power. Lowering the number of pipeline registers or using latch-based clocking methodologies and more efficient clock trees as would typically be done with custom design methodologies would help to greatly reduce Imagine's core power dissipation.



Figure 5.6: Measured Energy Efficiency

5.3 Energy Efficiency

Although absolute power dissipation for a processor is important since processors in embedded systems often have fixed power budgets, another important metric is energy efficiency, evaluated here as GOPS per Watt or Joules per operation. This metric corresponds to the energy which must be provided by an external source such as a battery in order to accomplish a fixed task, such as encoding one frame of video.

The sustained energy efficiency on Imagine, as picoJoules per arithmetic operation, is shown in Figure 5.6. At the nominal 1.5 Volt supply, Imagine dissipates 363 pJ per operation (2.4 GFLOPS/W). However, by operating Imagine at lower frequencies and lower supply voltages, its energy efficiency is improved [Chandrakasan *et al.*, 1994; Horowitz *et al.*, 1994; Burd and Brodersen, 1995]. Since energy efficiency is given by the ratio of performance to power (GOPS/W), as supply voltage approaches transistor threshold and delay increases, operating frequency and performance decrease. However, power is decreasing at a much faster rate, given by the product of voltage squared and operating frequency. At its most energy-efficiency condition (1.2 Volt supply), Imagine is 27% more energy-efficient than at the nominal supply voltage, dissipating only 265 pJ per operation. Below 1.2 Volts, the chip stops functioning correctly.

5.3. ENERGY EFFICIENCY

Processor	Volts	Tech	Data-	Peak	Power	Energy/Op
			type	Performance	(W)	(pJ)
Intel Pentium 4	1.5	0.13µ	FP	12 GFLOPS	80	6700
(3.08 GHz)			16b	24 GOPS	80	3350
SB-1250	1.2	0.15μ	FP	12.8 GFLOPS	10	780
(800 MHz)			64b	6.4 GOPS	10	1560
			16b	12.8 GOPS	10	780
TI C67x (225 MHz)	1.2	0.13µ	FP	1.35 GFLOPS	1.2	889
TI C64x (600 MHz)	1.2	0.13µ	16b	4.8 GOPS	0.72	150
Nvidia GeForce3	1.5	0.15μ	8-16b	1200 GOPS	12	10
Imagine	1.5	0.15μ	FP	5.3 GFLOPS	3.1	587
(132 MHz)			32b	5.3 GOPS	3.1	587
			16b	10.6 GOPS	3.1	293
Imagine Low-Voltage	1.2	0.15µ	FP	2.5 GFLOPS	1.1	423
(66 MHz)			32b	2.5 GOPS	1.1	423
			16b	5.0 GOPS	1.1	220
Imagine Normalized	1.2	0.13μ	FP	6.1 GFLOPS	2.0	328
to 0.13μ (150 MHz)			32b	6.1 GOPS	2.0	328
			16b	12.2 GOPS	2.0	164

Table 5.1: Energy-Efficiency Comparisons

To put these numbers in perspective, an energy-efficiency comparison between Imagine and some of media processors presented earlier in Section 2.1 is shown in Table 5.1. Energy efficiency is shown as energy per arithmetic operation and is calculated from peak performance and power dissipation. Unlike Section 2.1, here in Table 5.1, energy efficiencies are not normalized to the same technology, but rather each processor's technology and voltage is listed in the table.

The first section includes two microprocessors, a 3.08 GHz Intel Pentium 4¹ [Sager *et al.*, 2001; Intel, 2002] and a Sibyte SB-1250, which consists of two on-chip SB-1 CPU cores [Sibyte, 2000]. The Pentium 4 is designed for high performance through deep pipelining and high clock rate. The SiByte processor is targetted specifically for energy efficient

¹Gate length for this process is actually 60-70 nanometers because of poly profiling engineering [Tyagi *et al.*, 2000; Thompson *et al.*, 2001].

operation through extensive use of clock gating and other design techniques for low power. These processors demonstrate the range of energy efficiencies typically provided by microprocessors, over 500 pJ per instruction in a 0.13 micron technology.

Digital signal processors are listed next in Table 5.1. The first DSP, the TI C67x [TI, 2003], an 8-way VLIW operating at 225 MHz targets floating-point applications, and has energy efficiency of 889 pJ per instruction, similar to the SB-1250 when normalized to the same technology and voltage. The TI C64x [Agarwala *et al.*, 2002], a 600 MHz 8-way VLIW DSP targeted for lower-precision fixed-point operation, is able to provide improved energy efficiency over floating-point DSPs at 150-250 pJ per 16b operation. This improved efficiency is due to arithmetic units optimized for 16b operation and with architectures designed to efficiently exploit parallelism, such as SIMD operations in the C64x.

Although fixed-point DSPs are able to provide significant improvements over microprocessors in energy efficiency, special-purpose processors are still one to two orders of magnitude better, as demonstrated by the Nvidia Geforce3 [Montrym and Moreton, 2002; Malachowsky, 2002] at 10pJ per operation, or 5 pJ per operation when scaled to 0.13 μ m technology. The energy efficiency of graphics processors is due to their highly parallel architectures that provide a large amount of arithmetic performance with low VLSI overhead. In addition, graphics processors are able to exploit producer-consumer locality by feeding the output of one stage of the graphics pipeline directly to the next stage of the pipeline, avoiding global data transfers.

Finally, we present the energy efficiency of Imagine in Table 5.1. When normalized to the same voltage, Imagine dissipates nearly half the energy per floating-point op per 16-bit op dissipated by the SB-1250, the most energy efficient fully-programmable floating-point processor listed. When normalized to the same technology, Imagine provides energy efficiencies 2.7x better than the C67x on floating-point operations. On 16-bit operations, Imagine is comparable to the C64x, even though Imagine contains arithmetic units optimized for floating-point and 32-bit performance and a less aggressive design methodology. In the next section, we will explore the energy efficiency of stream processors optimized for 16-bit fixed-point applications rather than floating-point performance. In addition, we will demonstrate the potential of stream processors to achieve much higher energy efficiency by employing more-aggressive custom design methodologies rather than standard cells and by

Processor	Volts	Tech	Data-	Energy-Delay
			type	
Intel Pentium 4	1.5	0.13μ	FP	558
(3.08 GHz)			16b	140
SB-1250	1.2	0.15μ	FP	61
(800 MHz)			32b	244
			16b	611
TI C67x (225 MHz)	1.2	0.13μ	FP	658.5
TI C64x (600 MHz)	1.2	0.13μ	16b	31
Broadcom Calisto	1.2	0.13μ	16b	42.6
Nvidia GeForce3	1.5	0.15μ	8-16b	0.008
Imagine	1.5	0.15μ	FP	110
(132 MHz)			32b	110
			16b	27.6
Imagine Normalized	1.2	0.13µ	FP	54
to 0.13μ (150 MHz)			32b	54
			16b	13

Table 5.2: Energy-Delay Comparisons

using low-power circuit techniques. This would also provide a more fair comparison to the DSPs and microprocessors listed here, which also use custom design methodologies.

Some researchers have proposed using the energy-delay product as an alternate metric for energy efficiency [Horowitz *et al.*, 1994]. Since processors designed to operate at slower performance rates can reduce their energy per task with techniques such as smaller transistor sizing and less pipelining to reduce clock power (at the cost of higher delay per task), the energy-delay product metric allows one to compare the energy efficiency of two processors operating at different performance rates.

We evaluated energy-delay product on the same range of processors as shown in Table 5.2 (lower energy-delay product is better). As with energy efficiency, energy-delay is estimated from peak performance and power dissipation, given by the ratio of energy per operation to the peak performance on that operation type.

The energy-delay product is affected more than energy efficiency or performance alone by design methodologies and technology scaling. That is because the advantages in raw

Application	Operation	Performance	Core Power
	types	(GOPS)	(W)
MPEG-2 Encode	32b/16b/8b	4.9	3.6
QR Decomposition	Floating-point	3.4	4.4
Coherent Side-lobe Cancellation	Floating-point	2.3	4.5

 Table 5.3: Sustained Application Performance

performance and energy efficiency provided by smaller device sizes and custom circuits are compounded with energy-delay product. Nevertheless, when normalized to the same technology, Imagine still is less than half the energy-delay of the most energy-efficient DSPs on 16b operations. However, on floating-point, it is slightly worse than the SB-1250.

Several factors in the Imagine implementation lead to higher energy-delay products and energy efficiency than possible with a more optimal implementation of the Imagine architecture. First, as described in Section 5.1, if at 1.5V Imagine operated at the worst-case operating conditions predicted by static timing analysis of 188 MHz rather than the measured frequency of 132 MHz, it would see a 1.42x improvement in performance, without affecting energy efficiency. This would translate directly to a reduction in energy-delay product. Furthermore, by using more aggressive design methodologies and low-power circuit techniques, Imagine could easily operate at much higher frequencies, and could therefore provide additional reductions in its energy-delay product.

5.4 Sustained Application Performance

In addition to the peak numbers presented above for performance and power dissipation, Imagine is able to sustain a large percentage of its peak performance on most media applications. Using a PCI board containing an Imagine processor running at 144 MHz and 1.5 Volts², a PowerPC host processor running at 150 MHz, and a 66 MHz bus between the host processor and Imagine, Imagine sustained the application performance and power dissipation shown in Table 5.3. Imagine is able to sustain between 40% and 60% of peak

²This frequency is achievable at 1.5 Volts using the software workaround to the worst critical paths.

performance on these applications.

5.5 Summary

A prototype Imagine processor has been shown to provide a peak performance of 11.5 GFLOPS at its maximum frequency and to dissipate 423 pJ per floating-point operation at its most energy-efficient operating condition, more than twice as efficient as other programmable floating-point processors when normalized to the same technology. However, there is still a large gap in performance, area efficiency, and energy-efficiency of stream processors when compared to special-purpose processors, typically less than 10 pJ per operation in a 0.13 μ m technology. Stream processors have the potential to further close this gap by utilizing more aggressive custom design methodologies and utilizing low-power circuit techniques and energy-efficient ALU designs for 16-bit operations. In the next section, we extend stream processors to custom design methodologies and stream processors tailored for low-power embedded systems, demonstrating the potential for highly area- and energy-efficient stream processors.

Chapter 6

Stream Processor Scalability: VLSI Costs

The previous chapters in this thesis describe the VLSI implementation and evaluation of the Imagine stream processor, and demonstrated its capability of efficiently supporting 48 ALUs in a 0.15 μ m standard cell technology. In the following chapters, we extend this work by exploring the capability of scaling stream processors to many more ALUs per chip in future technologies and by exploring efficiency improvements with more aggressive design methodologies.

With CMOS technology scaling and improved design methodologies, increasing numbers of ALUs can fit onto one chip. On the Imagine stream processor, a multiplier supporting single-precision floating-point, 32-bit integer, and dual 16-bit integer multiplies has an area of 0.486 mm^2 (1224K grids) and an average energy per multiply of 185 pJ, including internal flip-flop power in pipeline registers. In comparison, custom implementations of similar multipliers scaled to the same technology would have an area of less than 0.26 mm^2 (655K grids) and energy of less than 50 pJ per multiply [Huang and Ercegovac, 2002; Nagamatsu *et al.*, 1990]. By only supporting 16-bit data-types, this custom multiplier area and energy could be further reduced to less than 15pJ [Goldovsky *et al.*, 2000]. Other components, such as register files, scale similarly to custom methodologies. This demonstrates the potential for large area and energy savings by employing custom design methodologies, rather than standard cells, and by tailoring datapaths to smaller widths if that is all that is required by the application. Furthermore, available on-chip arithmetic bandwidth increases by 70% each year [Dally and Poulton, 1998]. In a 45 nanometer technology, expected to be available by the end of the decade [SIA, 2001], the Imagine multiplier would scale to $0.044 \text{ } mm^2$. In this technology, over two thousand of these multipliers could fit on a single $1 \text{ } cm^2$ chip and could be easily pipelined to operate at over 1 GHz. At this speed, these multipliers could provide 2 Teraops per second of arithmetic bandwidth.

Although technology scaling and custom design methodologies provide the potential for thousands of ALUs per processor in the future technologies, conventional processor architectures do not scale effectively. Agarwal et al. studied the scaling of general-purpose microprocessors and showed that the performance of conventional superscalar microprocessors will be limited by wire delay and large global structures in future technologies [Agarwal *et al.*, 2000]. As a result, these microprocessors, which historically have been scaling at 50-60% annually, will be limited to 12.5% annual performance improvements when scaling from a 250 nanometer to 35 nanometer technology.

Furthermore, Rixner et al. studied the VLSI efficiencies of the register organizations in a variety of processors [Rixner *et al.*, 2000b]. A conventional processor with a inefficient single unified register file, for example, would have a support structure that would dwarf the area and power of the ALUs themselves. Stream processors, on the other hand, are areaand energy-efficient, primarily due to their partitioned register file structure, as described in Section 2.4.4.

In the remainder of this chapter, the feasibility of scaling stream processors to thousands of ALUs is explored. We develop a cost model that estimates the area, delay, and energy of a stream processor as a function of C the number of clusters and N the number of ALUs per cluster. We use these models to evaluate intercluster scaling (increasing C) and intracluster scaling (increasing N). Our analysis shows that scaling to hundreds of clusters with tens of ALUs per cluster incurs only modest penalties for energy and area. For example, a 640-ALU C = 128 N = 5 stream processor requires only 2% more area per ALU and only 7% more energy per ALU operation than a 40-ALU C = 8 N = 5 stream processor.

Param	Description	Value
A_{SRAM}	Area of 1 bit of SRAM used for SRF or Microcontroller	16.1
	(grids)	
A_{SB}	Area per SB width (grids)	2200
w_{ALU}	Datapath width of an ALU (tracks)	880
w_{LRF}	Datapath width of LRFs required per ALU (tracks)	440
w_{SP}	Scratchpad datapath width (tracks)	710
h	Cluster datapath height (tracks)	1400
v_0	Wire propagation velocity in tracks per FO4	1400
t_{cyc}	FO4s per clock	45
t_{mux}	Delay of 2:1 mux in FO4s	2
E_w	Normalized wire propagation energy per track	1
E_{ALU}	Energy of ALU operation (normalized to E_w)	2.0×10^6
E_{SRAM}	SRAM access energy per bit (normalized to E_w)	8.7
E_{SB}	SB access energy per bit (normalized to E_w)	1900
E_{LRF}	LRF access energy (normalized to E_w)	8.9×10^5
E_{SP}	SP access energy (normalized to E_w)	1.6×10^6
Т	Memory latency (cycles)	55
b	Data width of the architecture	32

Table 6.1: Building Block Areas, Energies, and Delays

6.1 VLSI Cost Models

The area, delay, and energy of a stream processor can be modeled by constructing a processor from a small set of basic building blocks: four types of on-chip memory (SRAMs, SPs, LRFs, and streambuffers), ALUs, and switches (wires). The SRAM area and energy is taken from a large single-ported SRAM macro whereas the SP memory is taken from a dual-ported memory. The LRFs and streambuffers were implemented with standard-cell latches and flip flops. The ALUs were implemented with standard-cell logic functions.

The area, delay, and energy of these basic building blocks, measured from the Imagine processor, are presented in Table 6.1. Area and energy measurements are normalized to process-independent values. For example, area values are normalized to units of minimum wire grids (0.40 square microns in the 0.18 micron technology used for Imagine). Energy values are normalized to E_w , the propagation energy for a minimum-width wire per wire

Param	Description	Value
G_{SRF}	Width of SRF bank per N (words)	0.5
G_{SB}	Average number of SB accesses per ALU operation in typical kernels	0.2
G_{COMM}	COMM units required per N	0.2
G_{SP}	SP units required per N	0.2
I_0	Initial width of VLIW instructions (bits)	196
I_N	Additional VLIW instruction width per function unit	40
L_O	Required number of non-cluster SBs	6
L_C	Initial number of cluster SBs	6
L_N	Additional SBs required per N	0.2
r_m	SRF capacity needed per ALU for each cycle of memory latency	20
	(words)	
r_{uc}	Number of VLIW instructions required in microcode storage	2048
C	Arithmetic clusters	
N	Number of ALUs per cluster	

Table 6.2: Scaling Coefficients

track of length (0.093 fJ per wire track in a 0.18 micron technology¹). Measured delays for on-chip wire propagation and key gates which will be used to construct large switches are presented in fan-out-of-4 inverter delays (FO4s), a process-independent measure of device speed. As technology scales, wire propagation velocity v_0 stays relatively constant with optimal repeatering [Ho *et al.*, 2001]. A clock cycle of 45 FO4s, measured from the Imagine stream processor, was used. Typical microprocessors designed with custom methodologies have clock cycles closer to 20 FO4s [Agarwal *et al.*, 2000]. Adapting the cost analysis to results for custom processors will be addressed in Section 6.3.

A stream processor can be constructed from the building blocks in Table 6.1. However, appropriate sizes and bandwidths must be chosen for structures such as the local register files, stream register file, microcontroller, and others. The values shown in Table 6.2 were used to govern how such structures should scale. These values were empirically determined from the inner loop characteristics of a variety of key media processing kernels, shown in

¹Calculated from an assumed wire capacitance of 0.26 fF per micron including repeater capacitance [Ho *et al.*, 2001] with a 25% 1-to-0 transition probability.

Kernel	ALU	SRF	Intercluster	SP
	Ops	Accesses	Comms	Accesses
Blocksad	59	28 (0.47)	10 (0.17)	4 (0.07)
Convolve	133	14 (0.11)	5 (0.04)	2 (0.02)
Update	61	4 (0.07)	16 (0.26)	32 (0.52)
FFT	145	64 (0.44)	40 (0.28)	72 (0.50)
DCT	150	16 (0.11)	7 (0.05)	32 (0.21)

Table 6.3: Kernel Inner Loop Characteristics

Table 6.3 with the number of accesses per ALU operation shown in parentheses. Based on these inner loop characteristics, reasonable values for G_{SRF} , G_{SB} , G_{SP} , and G_{COMM} were used to ensure that average application performance was not limited from microarchitectural assumptions. Also included in Table 6.2 are C and N, variables that will be varied throughout the chapter as the number of ALUs are scaled.

6.1.1 Stream Processor Cost Models

The total area and energy of a stream processor is subdivided into the SRF, the microcontroller, the C SIMD arithmetic clusters, and the intercluster switch. Other components such as the stream controller and memory system are not significantly scaled with the number of ALUs and contribute a small constant factor to total area, so are not considered in this study. Analytical cost models for the SRF, microcontroller, clusters, and switches are presented in Table 6.4 [Khailany *et al.*, 2003]. The first section contains dependent variables used for clarity, followed by formulae for area, delay, and energy. These models have been adapted from formulae presented by Rixner et al. on the Stream/SIMD/DRF register organization [Rixner *et al.*, 2000b]. However, Rixner et al. only considered the register files and the switches between register files and fixed C at 8 in their analysis. In this work, we extend the models to include the microcontroller, intercluster switches, and scratchpad units, and treat C as an independent variable.

A grid floorplan of arithmetic clusters shown in Figure 6.1 is assumed. The SRF is partitioned into C banks, where each bank corresponds to an element from a stream that



Figure 6.1: Scalable Grid Floorplan

a cluster will read during SRF reads and writes. The only communication between the clusters or SRF banks is in the memory system ports to the SRF (not shown) and the intercluster switch, with buses and cross-point switches represented as lines and dots in Figure 6.1.

Stream Register File

The area of the SRF, A_{SRF} , contains two components: the stream storage and the streambuffers (SBs). The SRF is used to stage streams passed between kernels. A SB automatically prefetches sequential data for its associated stream out of the stream storage. All SBs share a single port into the stream storage, allowing that single port to act as many logical ports. The stream storage is a large single-ported on-chip SRAM, organized as $r_m TN$ blocks of C banks, for a total capacity of $r_m TNC$ words. This capacity is necessary to cover external memory latency. In a fixed technology, since the area and access energy of the stream storage grow linearly with the capacity, both the area and energy grow linearly with the number of ALUs in a stream processor.

Each SB contains storage for two blocks of the SRF to act as a double-buffer for covering the latency of block reads and writes from the stream storage. Each SRF bank has a block width of $G_{SRF}Nb$, requiring $2G_{SRF}Nb$ bits of storage per SB. A total of N_{SB} streambuffers are required for a given stream processor configuration. As shown in Table 6.4, three factors determine the total number of SBs. L_O SBs are required for memory, host, and microcontroller transfers. L_C cluster SBs are required to provide an ample number of input and output streams for typical kernels. Finally, as N increases, more bandwidth is often required between some of the SBs and the ALUs. This is accounted for with a third term, L_NN . Input or output streams with multi-word records that require more bandwidth must be split into multiple streams and utilize these additional SBs to keep from becoming a performance bottleneck². Asymptotically, the area of the SBs grows with N^2 , but for N < 64, the linear term accounts for the majority of the area. The energy dissipated in the SBs is related to the number of SB accesses per ALU operations, G_{SB} . Half of the accesses are assumed to be reads and require a traversal of the intracluster switch.

Microcontroller

The microcontroller, listed next in Table 6.4, provides storage for the kernels' VLIW instructions, and sequences and issues these instructions during kernel execution. The microcode storage is a large single-ported memory. The microcontroller area is comprised of the microcode storage area and area for control wire distribution between the microcontroller and the clusters. The microcode storage requires r_{uc} VLIW instructions for kernel storage in typical applications. Although as is shown in Section 7.3, increasing N results in higher inner-loop performance, the number of instructions in a kernel stays relatively constant with N since more loop unrolling is often used with higher N to provide more ILP and

²Splitting multi-word-record streams into multiple streams was done by hand to optimize performance for the experiments in Section 7.3.

6.1. VLSI COST MODELS

Element	Equation
COMMs per	$N_{COMM} = G_{COMM}N$
Cluster	
SPs per cluster	$N_{SP} = G_{SP}N$
FUs per cluster	$N_{FU} = N + N_{SP} + N_{COMM}$
Cluster SBs	$N_{CLSB} = L_C + L_N N$
Total SBs	$N_{SB} = L_O + N_{CLSB}$
External	$P_e = N_{CLSB}$
Cluster Ports	
Total Area	$A_{TOT} = CA_{SRF} + A_{UC} + CA_{CLST} + A_{COMM}$
SRF Bank Area	$A_{SRF} = r_m T N A_{SRAM} b + (2G_{SRF} N) N_{SB} A_{SB} b$
Microcontroller	$A_{UC} = r_{uc}(I_0 + I_N N_{FU})A_{SRAM} +$
Area	$(I_N N_{FU})\sqrt{A_{SRF} + A_{CLST} + A_{COMM}}$
Cluster Area	$A_{CLST} = N_{FU}w_{LRF}h + Nw_{ALU}h + N_{SP}w_{SP}h + A_{SW}$
Intracluster	$A_{SW} = N_{FU}(\sqrt{N_{FU}}b)(2\sqrt{N_{FU}}b + h + 2w_{ALU} + 2w_{LRF}) +$
Switch Area	$\sqrt{N_{FU}}(3\sqrt{N_{FU}}b + h + w_{ALU} + w_{LRF})P_eb$
Intercluster	$A_{COMM} = CN_{COMM}b\sqrt{C}(N_{COMM}b\sqrt{C} + 2\sqrt{A_{CLST} + A_{SRF}})$
Switch Area	
Intracluster	$t_{intra} = \sqrt{N_{FU}}(h + 2\sqrt{N_{FU}}b + w_{ALU} + w_{LRF} + \sqrt{N_{FU}}b)/v_0 +$
Wire Delay	$t_{mux}(\log_2 \sqrt{N_{FU}} + \sqrt{N_{FU}})$
Intercluster	$t_{inter} = t_{intra} + 2\sqrt{CA_{CLST} + CA_{SRF} + A_{COMM}}/v_0 +$
Wire Delay	$t_{mux}(\log_2\sqrt{CN_{COMM}}+\sqrt{C})$
Total Energy	$E_{TOT} = CE_{SRF} + E_{UC} + CE_{CLST} + G_{COMM}NCbE_{inter}$
SRF Bank	$E_{SRF} = r_m T N b E_{SRAM} G_{SB} / G_{SRF} + (G_{SB} N b) (E_{SB} + E_{intra}/2)$
Energy	
Microcontroller	$E_{UC} = r_{uc}(I_0 + I_N N_{FU}) E_{SRAM} +$
Energy	$(I_N N_{FU}) E_w (\sqrt{C} \sqrt{CA_{SRF} + CA_{CLST} + A_{COMM}})$
Cluster Energy	$E_{CLST} = N_{FU}E_{LRF} + NE_{ALU} + G_{SP}NE_{SP} + N_{FU}bE_{intra}$
Intracluster	$E_{intra} = E_w \sqrt{N_{FU}} ((h + 2\sqrt{N_{FU}}b) + 2(w_{ALU} + w_{LRF} + \sqrt{N_{FU}}b))$
Switch Energy	
Intercluster	$E_{inter} = E_w(2\sqrt{C})(\sqrt{A_{CLST} + A_{SRF}} + N_{COMM}b\sqrt{C})$
Switch Energy	

Table 6.4: Scaling Cost Models

because loop prologues and epilogues in kernels are critical-path limited, not arithmeticbandwidth limited. The width of each VLIW instruction is given by $I_0 + I_N N_{FU}$ bits. I_0 bits are required for microcontroller instruction sequencing, conditional stream instructions, immediate data, and for interfacing with the SRF. I_N bits per ALU per cluster are required to encode ALU operations, to control LRF read and writes, and to control the intracluster switch. Area and energy for distributing the instructions from the microcode storage to the grid of clusters is accounted for in the second term in both formulae in Table 6.4. In addition, repeaters and pipeline registers are required within the cluster grid for more instruction distribution, but this area is accounted for in the area measured for the components in Table 6.2.

Arithmetic Clusters

Each cluster is comprised of area devoted to the LRFs, ALUs, a scratchpad, and the intracluster switch. This switch is a full crossbar that connects the outputs of the FUs and the streambuffers to the inputs of the LRFs and the streambuffers. In this study, the ALUs are assumed to be arranged in a square grid as shown in Figure 6.2, where each row contains a bus for each ALU output in that row and each column contains a bus for each LRF input in that column. The row-column intersections contain program-controlled cross-point switches that connect rows to columns. This grid structure minimizes the area and wire delay of the intracluster switch when the number of ALUs per cluster is large³. The area devoted to the intracluster switch includes wire tracks for the wires and repeaters in the rows and columns of the grids and the cross-points between the rows and columns, as shown in Figure 6.2. Additional area for the external ports from the cluster streambuffers is included as well. Area from the control wires for the crosspoints is ignored for simplicity since it is small when compared to the area for the data wires.

Table 6.4 also includes equations for the energy dissipated in an arithmetic cluster⁴ and the intracluster wire delay. For wire delay, the first term in E_{intra} models the worst-case wire propagation delay incurred in the intracluster switch (width + height of a cluster)/ v_0 and a term for the logic delay through the cross points. The logic delay includes a $\sqrt{N_{FU}}$:1 mux for each row-column to select which ALU to read from on that row, followed by

³For smaller numbers of ALUs per cluster, a linear floorplan has comparable area and delay, but for simplicity, only grid floorplans are considered in this study.

 $^{{}^{4}}E_{CLST}$ from Table 6.4 includess a correction from [Khailany *et al.*, 2003] for the term modeling energy dissipated in the scratchpad.



Figure 6.2: Intracluster Switch Floorplan

an additional 2:1 mux delay at each additional row in the column to choose between the current row or the adjacent rows. As N increases, the VLSI costs of the arithmetic clusters are dominated by the $N_{FU}^{3/2}$ term in the intracluster switch area.

Intercluster Switch

The final component of the stream processor area is the intercluster switch, shown in Figure 6.1. Each cluster has N_{COMM} buses it broadcasts to in the rows and N_{COMM} buses it reads from in the columns. Since each cluster can only access stream elements from its SRF bank, the intercluster switch allows kernels that aren't completely data parallel to communicate data with each-other without going back to memory. It is also used by conditional streams to route data to and from the SRF [Kapasi *et al.*, 2000]. A two-dimensional grid structure similar to the intracluster switch is also assumed for the floorplan of the arithmetic clusters. This layout minimizes the area, delay, and energy overhead of the intercluster has N_{COMM} buses it writes to in each row and reads from in each column, so there is a bus width of $N_{COMM}b\sqrt{C}$ between each arithmetic cluster. As shown in E_{COMM} , on average,



Figure 6.3: Area of Intracluster Scaling

 $G_{COMM}NC$ intercluster communications will occur for every NC ALU operations, where each intercluster communication switches the capacitance for a bus in its row and in its destination's column.

6.2 VLSI Cost Evaluation

In this section, the area and energy costs of increasing the number of ALUs in a stream processor will be evaluated using the models presented above. The two scaling methods that will be explored are *intracluster scaling*, increasing the number of ALUs per arithmetic cluster, and *intercluster scaling*, increasing the total number of arithmetic clusters.

6.2.1 Intracluster Scaling

As N increases, the size and bandwidth of the SRF, clusters, micro-controller, and intercluster switch are all scaled according to the formulae presented in section 6.1. Figure 6.3 shows the area per ALU for intracluster scaling with C fixed at 8. Average energy dissipated per ALU operation is shown in Figure 6.4. Both charts are normalized to the values



Figure 6.4: Energy of Intracluster Scaling

for N = 5, the most area- and energy-efficient configuration. For small N, the overhead from the I_0 bits of microcode storage and the COMM and SP units contributes to larger area per ALU. The area per ALU then stays within 16% of the minimum up to 16 ALUs per cluster, at which point the intracluster and intercluster switch start to reduce the area efficiency. The energy efficiency follows a similar trend, although by 16 ALUs per cluster the energy per ALU op has grown to 1.22x of the minimum, due to the intracluster switch and microcontroller instruction distribution to the large arithmetic clusters.

6.2.2 Intercluster Scaling

Compared to intracluster scaling, intercluster scaling incurs more modest VLSI costs because the intercluster switch grows more slowly than the intracluster switch as the number of ALUs per processor are increased. Figure 6.5 shows the area per ALU as C is increased from 8 to 256, assuming a constant cluster size of N = 5. The area per ALU is normalized to the C = 8 N = 5 processor for comparison to stream processors feasible in today's technology. The C = 32 processor actually has 3% improved area per ALU over the C = 8processor as the cost of the micro-code storage is amortized over more clusters. However



Figure 6.5: Area of Intercluster Scaling

at C = 128, the area per ALU is 2% worse than for C = 8, mostly due to area in the intercluster switch. As shown in Figure 6.6, energy overhead grows slightly faster than area. A C = 128 dissipates 7% more energy per ALU operation than for C = 8.

6.2.3 Combined Scaling

By combining intercluster and intracluster scaling, configurations with thousands of ALUs are feasible, as shown in Figure 6.7. The area per ALU is graphed for 2, 5, and 16 ALUs per cluster with the number of clusters shown on the x-axis. These results show that by scaling to N = 5, then employing intercluster scaling provides the most area- and energy-efficient configurations over the range of C from 8 to 128. This is because the additional cost of supporting more than one port into the intercluster switch hurts area and energy efficiency standpoint for N > 5. However, it is not prohibitively expensive: the additional cost of scaling from N = 5 to N = 10 is only 5-11% and 8-13% worse for area and energy per ALU depending on C.


Figure 6.6: Energy of Intercluster Scaling



Figure 6.7: Area of Combined Scaling

As technology enables more ALUs to fit on a single chip, architectures must efficiently utilize bandwidth in order to achieve large performance gains. Intracluster scaling was shown to be effective from a cost standpoint up to 10 ALUs per cluster, although was most area- and energy-efficient at 5 ALUs per cluster. Intercluster scaling was shown to be effective up to 128 clusters with a slight decrease in area and energy efficiency, although was most area-efficient at 32 clusters. Together, these two scaling techniques enable area- and energy-efficient stream processors with thousands of ALUs.

6.3 Custom and Low-Power Stream Processors

Although the preceding analysis used technology parameters typical to a less-aggressive standard-cell design methodology, the results would be similar for a full-custom design. Full-custom processors have clock cycles of less than 20 FO4s [Agarwal *et al.*, 2000], but also have smaller functional units and register files, leading to higher absolute performance and lower absolute area and energy.

In this section, we demonstrate the effect of design methodologies and operand types on area and energy efficiency by considering three stream processor types, each with different area, energy, and ALU types, but the same underlying stream architecture. The first type, ASIC, assumes a standard-cell design methodology, and uses measurements of area, delay, and energy of key components taken directly from the Imagine stream processor. The second type, CUST, is functionally equivalent to ASIC, but assumes custom design methodologies for key blocks, leading to improved area and energy efficiency and clock frequency. Finally, the third type, LP, is a stream processor targeted for low-power embedded systems that only requires lower-precision fixed-point data-types. It also assumes full-custom circuits similar to CUST. However, rather than supporting both 32-bit mixed floating-point/integer ALUs and dual 16-bit operations, LP only supports dual 16-bit fixedpoint fused multiply-add units similar to the DOTP instructions in the Texas Instruments C64x instruction set [Golston, 2000].

The analytic models presented in the previous section can be used to study the area and energy efficiency of the ASIC, CUST, and LP configurations. Note that this only models the area and power in the arithmetic clusters, SRF, and microcontroller. The analysis for

Param	Description	ASIC	CUST	LP
w_{ALU}	Datapath width of an	876.9	1447 (Aggr)	515
	ALU (tracks)		1918 (Cons)	
w_{LRF}	Datapath width of LRFs re-	437.0	92.1	92.1
	quired per ALU (tracks)			
w_{SP}	Scratchpad datapath width	708.9	1551	1551
	(tracks)			
A_{SB}	Area per SB width (grids)	2161.8	230.3	230.3
h	Cluster datapath height	1400	640	640
	(tracks)			
E_{ALU}	Average energy of ALU	2.0×10^6	$6.8 \times 10^5 (Aggr)$	6.3×10^{5}
	operation (normalized)		2.0×10^6 (Cons)	
E_{LRF}	LRF access energy (normal-	8.9×10^5	7.9×10^4	7.9×10^4
	ized)			
E_{SB}	SB access energy per bit (nor-	1936	155	155
	malized)			
t_{cyc}	FO4s per clock	45	20(Aggr)	45
			45(Cons)	
Т	Memory latency (cycles)	55	80(Aggr)	55
			55(<i>Cons</i>)	

Table 6.5: Building block Areas, Energies, and Delays for ASIC, CUST, and LP

these units suggests improvements applicable to the full stream processor design through custom circuit methodologies, however, the analysis is simplified by only studying these units, which comprise over 70% of the active chip area and power dissipation.

In order to model area and energy costs across the various configurations, it suffices to vary the area and energy of the building block parameters across the configurations and then use the analytical models presented it Section 6.1. The parameters that were varied are presented in Table 6.5, again normalized to technology-independent units. For the ASIC configuration, the above values are those presented in Table 6.1 taken from the Imagine stream processor. For the CUST configuration, there are two configurations considered. The *aggressive* (Aggr) numbers assume custom cells for ALUs and register files (LRFs and SBs) whereas the *conservative* (Cons) only assumes custom cells for register files with

		ASIC	CUST_CONS	CUST_AGGR	LP
Area	mm^2	39.7	32.4	28.4	18.2
			(1.2x)	(1.4x)	(2.2x)
Frequency	MHz	340	340	770	340
Peak Perf	GFLOPS	13.7	13.7	30.8	N/A
	16b GOPS	27.4	27.4	61.6	54.7
Power	W	2.8	5.1	3.2	1.2
Energy	FP pJ/Op @1.2 V	208	161	105	N/A
Efficiency	16b pJ/Op @1.2 V	104	81	52	21.5
	FP pJ/Op @0.8 V	93	72	47	N/A
	16b pJ/Op @0.8 V	46	36	23	10
			(1.3x)	(2.0x)	(4.8x)
Energy	pJ/Op/GFLOPS	15.2	11.8	3.4	N/A
Delay	pJ/Op/16b GOPS	3.8	3.0	0.85	0.39
Product	(1.2 V)		(1.3x)	(4.5x)	(9.7x)

Table 6.6: ASIC, CUST, and LP performance efficiencies

the ASIC ALUs. Register file area and energies were taken from custom register files implemented in the same technology as Imagine. ALU data was taken from published 32b multiplier designs [Huang and Ercegovac, 2002; Nagamatsu *et al.*, 1990]. Note that the width of various units also changed since a smaller datapath height is assumed with the custom configuration. Although memories and register files are well documented, it is difficult to predict exact area and energy of custom ALU designs due to lack of published data, so carrying out an analysis with both the CUST_AGGR and CUST_CONS configurations demonstrates the sensitivity of area and energy to individual ALU designs.

For the LP processor, custom cells were also assumed for both custom ALUs and register files. A dual 16b fused-multiply-adder is used with area and energy taken from published 16b multipliers [Goldovsky *et al.*, 2000]. Finally, the CUST_AGGR configuration is assumed to have a clock cycle of 20 FO4 inverter delays per cycle, more typical of custom processors [Agarwal *et al.*, 2000]. This difference in clock cycle time also affects memory latency, although not exactly by 2.5x since much of the memory latency is incurred through cycles in the on-chip memory controller. The LP configuration is less aggressively pipelined than CUST_AGGR at 45 FO4 delays per cycle in order to reduce power overhead

in pipeline registers.

Using the models presented in Section 6.1, estimates for area and energy per operation in the clusters, SRF, and microcontroller were generated. These results are shown in Table 6.6, assuming a 1.2 Volt, 0.13 μ m technology. In this technology, the minimum wire pitch is 0.46 μ m and a FO4 inverter has a delay of 65 ps. The CUST_CONS configuration is 80% the size of ASIC, due to the smaller LRFs and SBs. Further area reduction occurs when moving to custom ALUs in the CUST_AGGR configuration. The LP configuration has an additional 36% improvement in area over CUST_AGGR because w_{ALU} is significantly smaller, since the 16-bit multiply-add unit only is required to sum half as many partial products as the multiplier in CUST_AGGR. Supporting multiply-add instructions in the LP configuration also enables twice the peak 16b performance when compared to CUST_CONS.

The energy efficiency savings from moving to custom design methodologies can be seen when comparing the power of ASIC and CUST_AGGR. Although it has 14% higher power dissipation, CUST_AGGR is operating at more than twice the frequency, meaning that significantly less energy is dissipated per clock cycle. Furthermore, the LP configuration is more than twice as energy-efficient as CUST because each multiply-add operation consumes less energy but is doing twice the GOPS. Additional energy-efficiency improvements can be achieved in all configurations by operating at a lower voltage. Note that the energy-efficiencies in Table 6.6 can not be compared directly to other processors, since they do not take into account other sources of power dissipation in a processor, such as the clock tree. However, the 4.8x improvement in energy-efficiency suggests that similar energy savings could be achieved in the clock tree and other parts of the chip by employing custom design methodologies and using other custom circuit techniques.

These results for custom and low power processors can be further extended by combining them with the scalability models from Section 6.1 and the technology scaling parameters shown in Table 6.7. The parameters in the top part of the table are based on projections for future technologies [Ho *et al.*, 2001; SIA, 2001]. The wire capacitance printed assumes no miller capacitance from adjacent wires, the assumption used for calculating average case power dissipation. Architectural scaling assumptions are shown in the bottom part of the table. Since intercluster scaling enables scaling with near-constant area-efficiency, each

L_{drawn}	$0.18 \mu m$	$0.13 \mu m$	$0.09 \mu m$	$0.65 \mu m$	$0.45 \mu m$
Volts	1.5	1.2	1.0	0.9	0.9
FO4 Delay (ps)	90	65	45	33	23
Wire cap (fF/ μ m)	0.220	0.212	0.207	0.191	0.178
ALU Clusters	8	16	32	64	128
ALUs	40	80	160	320	640
ASIC, LP, CUST_CONS	0.25	0.34	0.49	0.68	0.99
Frequency (GHz)					
CUST_AGGR	0.56	0.77	1.1	1.5	2.2
Frequency (GHz)					
ASIC, CUST_CONS	9.9	27.4	79.0	219	632
Peak Performance (GFLOPS)					
CUST_AGGR	22.2	61.6	178	492	1422
Peak Performance (GFLOPS)					
LP Peak Perf (16b GOPS)	39.5	109	316	875	2528

Table 6.7: Technology Scaling Parameters

technology generation allows for a doubling in the number of arithmetic clusters. ALUs per cluster in Table 6.7 are held constant at 5, the most area- and energy-efficient organization. The increase in ALU count with each technology generation can be coupled with an increase in clock frequency due to decreasing gate delay, allowing for a total improvement in peak performance of 64x across 5 generations of technology scaling.

The results for area and power scaling across technology generations are shown in Figure 6.8. Note that the area stays relatively constant for all configurations. With each generation, approximately twice the number of transistors can fit into the same die area. Since area-efficiency stays near constant with intercluster scaling, area also stays near constant. In contrast, power dissipation increases gradually with technology. Although energy efficiency stays near constant with intercluster scaling in the same technology, voltage is not projected to scale aggressively enough to counteract the additional switched capacitance with a larger number of clusters.

Energy efficiency scaling is shown in Figure 6.9. For both floating-point and 16b operations, energy efficiency shows dramatic improvements. Since energy-efficiency stays



Figure 6.8: Effect of Technology Scaling on Die Area and Power Dissipation



Figure 6.9: Effect of Technology Scaling on Energy Efficiency

near constant with the number of clusters, this improvement is due solely to technology advances. And since energy efficiency is independent of frequency, it is improving by CV^2 scaling, allowing for an improvement of 29x across five future technology generations.

In summary, by utilizing custom methodologies and fixed-point arithmetic units commonly found in DSPs, area and energy efficiency of stream processors can be greatly improved. SRF, microcontroller, and cluster area was shown to be reduced by 30% when using custom methodologies, while energy efficiency was improved by 2.0x. Energy is further reduced with dual-16b multiply-add units for an average energy savings of 4.8x per operation. These area and energy efficiency improvements suggest that total stream processor efficiency would scale accordingly and would therefore be an order of magnitude better in raw performance, performance per unit area, and energy per operation than current programmable architectures.

Chapter 7

Stream Processor Scalability: Performance

As presented in the previous chapter, the efficiency of the stream processor register organization enables scaling to thousands of ALUs providing Teraops per second of peak performance with only a small degradation in area and power efficiency. However, peak performance and VLSI efficiency alone does not prove that a stream processor can scale effectively. Performance efficiency (performance per unit power or performance per unit area) is achieved by combining VLSI efficiency with high sustained performance.

In this chapter, we evaluate how sustained application and kernel performance scales as the number of ALUs per stream processor are increased with intracluster and intercluster scaling. First, we explore how the technology trends of limited off-chip memory bandwidth and increasing on-chip wire delay affect microarchitecture and performance. Then, we demonstrate how a stream processor is able to effectively exploit both instruction-level and data-level parallelism in key media processing kernels and applications to take advantage of both intracluster and intercluster scaling.

7.1 Related Scalability Work

Before presenting the scalability of stream processors, it is worth noting that stream processors, like vector processors, are able to exploit both instruction-level and data-level parallelism. Therefore, previous work on the scalability of vector processors with media applications will have some similarities to the studies carried out in this chapter.

Although stream and vector processors share the ability to exploit both instruction-level and data-level parallelism, they do so with different execution models. Vector microprocessors [Kozyrakis, 2002; Wawrzynek *et al.*, 1996] directly execute vector instructions such as vector adds or multiplies out of a vector register file. This differs from stream processors, which execute VLIW instructions from a kernel in a SIMD fashion out of a SRF and contain LRFs to store intermediate results.

Related scalability work in vector processors consists of cost models and sustained performance on media applications as the number of arithmetic units per processor are increased. Several authors have analyzed the VLSI costs of components of vector micro-processors as the number of function units per vector lane is increased [Asanovic, 1998; Kozyrakis, 2002; Rixner *et al.*, 2000b]. Kozyrakis also analyzed the natural vector lengths in media benchmarks and the performance of vector microprocessors as the number of FUs per vector lane are increased [Kozyrakis and Patterson, 2002]. These studies demonstrate the scalability of vector processors on media applications to tens of arithmetic units per processor using 8 vector lanes. However, to our knowledge, no previously published studies explore VLSI costs or performance as vector microprocessors are scaled to greater than 8 or 16 vector lanes. In the remainder of this chapter, similar scalability studies are applied to the stream processor model, demonstrating the scalability of stream processors to hundreds of arithmetic units per processor and leading to different tradeoffs between instruction-level and data-level parallelism.

7.2 Technology Trends

7.2.1 Memory Bandwidth

In order for a stream processor to effectively scale to hundreds of arithmetic units by the end of the decade, there must be enough memory bandwidth available for media application requirements. Fortunately, due to the advent of high-bandwidth memory systems and high compute intensity in media applications, hundreds of arithmetic units could be supported in future technologies without media applications becoming memory limited.

While available on-chip arithmetic bandwidth is increasing at 70% annually, off-chip pin bandwidth is only increasing by 25% each year [Dally and Poulton, 1998] if only standard scaling techniques are used. As explained in Section 2.4, Imagine deals with this bandwidth gap by mapping stream programs onto a three-tiered bandwidth hierarchy and by efficiently exploiting locality. Producer-consumer locality is exploited by passing streams between kernels through the second tier of the bandwidth hierarchy, the SRF. Kernel locality is exploited by keeping all temporary data accesses during kernel execution in the LRFs within the arithmetic clusters, the third tier of the hierarchy. Using these techniques, Imagine is able to sustain high arithmetic performance with significantly lower off-chip bandwidth. Imagine contains 40 fully-pipelined ALUs and at 232 MHz, provides 2.3 GB/s of external memory bandwidth, 19.2 GB/s of SRF bandwidth, and 326.4 GB/s of LRF bandwidth. This bandwidth hierarchy on Imagine provides a ratio of ALU operations to memory words referenced of 28.

Although Imagine can execute applications with compute intensities of greater than 28 without becoming memory-bandwidth limited, this threshold would increase for future stream processors as off-chip bandwidth grows more slowly than arithmetic bandwidth. Assuming the scaling factors for arithmetic and off-chip bandwidth above, this threshold will grow at 36% annually, meaning if stream processors arithmetic performance increased at 70% annually, in five years, applications with compute intensities of less than 130 would be memory-bandwidth limited. Fortunately, with the advent of memory systems optimized for bandwidth and the large and growing compute intensity of media applications, this

problem can be mitigated. For example, a stream processor with a 16 GB/s memory system, achievable with eight Rambus channels [Rambus, 2001], could support 400 1 GHz arithmetic units without being memory-bandwidth limited on applications requiring greater than 100 operations per memory reference. This suggests that the bandwidth hierarchy in stream processors should be able to scale effectively to hundreds of ALUs and provide large speedups without becoming memory bandwidth limited.

7.2.2 Wire Delay

Not only is memory bandwidth becoming even more of a scarce resource in modern VLSI technology, but another issue facing modern microarchitecture is on-chip wire delay. As technology has scaled, wire resistance per unit length has been increasing while gate delay has been decreasing [Ho *et al.*, 2001]. These trends are projected to continue in future technologies. As a result, when scaling to hundreds and thousands of ALUs per processor, large wire delays will be incurred across both the intercluster and intracluster switches and therefore these delays must be explicitly handled by the microarchitecture. Using the scaling models presented in Section 6.1, the wire delays through both the intracluster and intercluster and an another and an another and an another

For intracluster scaling, the worst-case switch delays of intracluster and intercluster communications are shown in Figure 7.1. As N increases, intercluster wire delay grows considerably. This delay is dominated by the wire delay between the large clusters. The intracluster delay grows at a lower rate, and includes significant components of both logic and wire delay. A clock cycle of 45 FO4 delays is assumed, the same clock rate measured on the Imagine processor, so it is visible from the graph when cycles of latency would need to be added as N is increased.

Worst-case switch delays with intercluster scaling are shown in Figure 7.2. Intracluster delay stays constant because the size of each cluster does not change. Increased intercluster delay is incurred mostly from wire delay and not logic delay.

Although both scaling techniques lead to greater switch delays, the grid layout of both the intracluster and intercluster switches can be fully pipelined, meaning that scaling incurs additional switch traversal latency, but does not affect overall processor clock rates.



Figure 7.1: Worst-case Switch Delay with Intracluster Scaling

With the two-dimensional grid floorplan for the intercluster switches shown in Figure 6.1, fully pipelined operation can be supported with the insertion of pipeline registers under the wires (along with buffers and repeaters) and a few control wires, not shown in the figure. Within each row, each cluster broadcasts its data across the row, for a total of $N_{COMM}C$ buses. If more than one cycle is required to account for wire delay within a row, then pipeline registers must be inserted at this stage. Meanwhile, each destination cluster read port broadcasts its associated source cluster across its column (not shown in the figure). Again, if this traversal requires more than one cycle, pipeline registers must also be inserted for these control wires. Furthermore, additional pipeline registers may be required at some cross points in order to make all switch delays equal to the worst-case pipeline delay. The vertical control and horizontal data wires then meet at the cross points and the appropriate row buses are muxed onto the vertical data buses. Similarly, pipeline registers along vertical wires may also be required for various configurations. In this manner, a fully pipelined crossbar between clusters is achievable. Similar pipelined operation can also be



Figure 7.2: Worst-case Switch Delay with Intercluster Scaling

implemented in the intracluster switch. For simplicity, it can be assumed that the area and power of these pipeline registers are small when compared to the buffers and repeaters required for the switches.

With pipelining, longer switch delays do not have an effect on clock rate, but these delays do have a significant effect on microarchitecture. Additional delay in the intracluster switch affects operation latency during kernel operation. On the Imagine processor, approximately one half of each execution unit's last pipeline stage clock cycle was allocated for traversing the intracluster switch. As shown in Figure 7.1, when N increases to greater than 14 ALUs, the worst-case delay across the intracluster switch is greater than half of a clock cycle. For N > 14, additional pipeline stages must be added to all ALU operations in order to account for this wire delay in the intracluster switch. In Section 7.3, the effect this operation latency has on performance will be presented. Note that in configurations with multi-cycle worst-case switch traversals, ideally the VLIW kernel compiler could exploit locality in the placement of operations onto the ALUs so that most communications would take place in a single clock cycle and only rarely will data have to be communicated all the way across the cluster. However, this compiler optimization was not available at the time of this study, so was not considered in the performance analysis.

Wire delay in intercluster communications also has an effect on microarchitecture. At C = 128 in Figure 7.2, the worst case delay between clusters requires three clock cycles to traverse the switch. As these multi-cycle worst-case intercluster switch traversals become necessary, three types of instructions must be modified to account for this delay. First, all COMM unit instructions must include additional latency. Second, latency must be also added to many of the instructions used to implement conditional streams. For example, latency must be added to the GEN_CISTATE and GEN_COSTATE instructions executed by the JB since they require communicating 1-bit CC values between all C clusters. Finally, the CHK_ANY and CHK_ALL instructions executed by the microcontroller require additional latency for broadcasting 1-bit CC's from all C clusters to the microcontroller. These changes can easily be handled without affecting instruction throughput by adding execution unit pipeline stages to the microarchitecture, a change easily supported by the VLIW kernel scheduler. In addition to increased operation latency, additional pipeline stages must be added to the instruction distribution (DECODE/DIST) stage in the kernel execution pipeline shown in Figure 3.6. The performance impact for both increased operation latency and pipeline depths will be presented in Section 7.3.

In summary, communication delay across switches must be accounted for as intracluster and intercluster scaling are used. With a 45 FO4 delay clock cycle and using the analytical models presented in Section 6.1, these delays are shown to be manageable with pipelined switches and by managing this switch latency with the VLIW kernel compiler. For example, when scaling to a C = 128N = 5 processor, only 3 cycles are required for traversing the intercluster switch. In the following sections, we account for this wire delay when measuring the performance of intracluster and intercluster scaling on a set of key media processing kernels and applications.

7.3 **Performance Evaluation**

In order to gain insight into the sustained performance on these kernels and applications using intracluster and intercluster scaling, sustained performance was evaluated on media processing kernels and applications. Previously, typical ratios between arithmetic operations and COMM, SP, and SRF accesses in kernel inner-loops were presented in Table 6.3. These ratios were used to govern how to scale key stream processor components. As a result, sustained performance on average is not limited by available throughput in the COMM or SP units, nor by SRF bandwidth. However, other application characteristics such as available instruction-level parallelism (ILP) and data-level parallelism (DLP) in kernel inner-loops, stream lengths, and wire delay have an influence on sustained performance with intracluster and intercluster scaling. In this section, these effects on performance are explored.

Performance was evaluated with six media processing kernels and six applications, summarized in Table 7.1. Kernels and applications were written in *KernelC* and *StreamC*. StreamC specifies how streams are passed between kernels. KernelC contains the mathematical operations for the kernel codes. Each kernel and application was then re-compiled for different architectures using the compilation and programming tools developed for the Imagine stream processor. Kernel inner-loop performance was measured from static analysis of compiled kernels. Applications were simulated on a C++ cycle-accurate simulator, holding the dataset size constant across all stream processor sizes.

The stream processor simulated assumes symmetric ALUs, where every function unit can perform multiplies, adds, shifts, or logical operations. Clock rates and external bandwidths were set to values typical for a 45 nanometer technology [SIA, 2001]. In this technology, a 45 FO4 inverter delay clock period would have a 1GHz processor clock rate. In addition, a memory system able to provide 16 GB/s of external memory bandwidth using eight Rambus channels [Rambus, 2001] and a 1GHz host processor issuing stream instructions across a 2GB/s channel were simulated.

7.3.1 Kernel Inner-Loop Performance

Kernel inner-loop performance is an important metric for predicting application performance. When running typical media processing applications like DEPTH on the Imagine

Kernel/APP	Data	Description
Blocksad	16b	Sum-of-absolute differences kernel for image processing
Convolve	16b	Convolution filter for image processing
Update	FP	Matrix block update for QRD
FFT	FP	Radix-4 fast Fourier transform
Noise	FP / 32b	Perlin noise function used in procedural marble shader
Irast	FP	Triangle rasterizer
RENDER	FP / 32b	Polygon rendering of a bowling pin with a procedural mar-
		ble shader.
DEPTH	16b	Stereo Depth Extraction on a 512x384 pixel image [Kanade
		<i>et al.</i> , 1996]
CONV	16b	Convolution filter on 512x384 pixel image
QRD	FP	256x256 Matrix Decomposition
FFT1K	FP	1024-point complex FFT
FFT4K	FP	4096-point complex FFT

Table 7.1: Kernels and Applications use for Performance Evaluation

stream processor, over 80% of execution time is spent in kernel inner loops.

In order to study the effect of intercluster and intracluster scaling on kernel inner-loop performance, a suite of kernels was compiled for various stream processor sizes. Functional unit latencies were taken from latencies in the Imagine stream processor and the latencies of communications were taken from the results presented in Section 6.2. In the Imagine design, half of a 45 FO4 cycle was allocated for intracluster communication delay. Therefore, for configurations with N > 12, where more than a half-cycle is required for intracluster communication, an additional pipeline stage was added to ALU operations and streambuffer reads to cover this latency. Similarly, the COMM unit operation latency and instruction issue pipeline depth was determined by the intercluster communication delay.

Intracluster Scaling

Whereas intercluster scaling exploits data-level parallelism (DLP) by operating on more than one stream element in parallel, kernel inner-loop performance with intracluster scaling is influenced by the ability of the VLIW kernel compiler to exploit ILP. ILP can be classified



Figure 7.3: Intracluster Scaling with no Loop Transformations

into three categories:

- True ILP within one iteration of a kernel inner-loop
- DLP converted to ILP via software pipelining.
- DLP converted to ILP via loop unrolling.

Each category affects the tradeoffs between intracluster and intercluster scaling in slightly different ways. True ILP can only be exploited by intracluster scaling and therefore intracluster scaling that exploits true ILP does not degrade intercluster scaling. Software pipelining and loop unrolling are loop transformations that convert DLP between loop iterations into ILP within kernel inner-loops. These transformations benefit intracluster scaling without affecting inner-loop performance with intercluster scaling. However, note that software pipelining and loop unrolling exploit parallelism which could have also been exploited directly by intercluster scaling. For this reason, these different forms of ILP must be treated separately in order to explore the tradeoffs between intracluster and intercluster scaling.

First, intracluster scaling exploiting true ILP in kernel inner-loops is presented. Figure 7.3 shows this inner-loop performance without the use of software pipelining or loop unrolling. In other words, each inner loop iteration processes only one element of a stream. For example, the FFT kernel executes one butterfly operation and the noise kernel runs a perlin noise function shader for one fragment. All kernels were scheduled with intracluster and intercluster switch latencies for a C = 8 processor, with N varied from 2 to 14. The top graph shows the average instructions per cycle (IPC) executed in each cluster within the kernel inner loops. IPC ranges from 0.90 to 1.39 for N = 2 and from 0.89 to 4.17 for N = 12, the highest performing configuration. The harmonic mean across all kernels is shown in bold¹. Most kernels have average IPCs of less than 2.5 for all ranges of ALUs. The one exception is the convolve kernel, which has a significant amount of ILP within the inner loop. However, for the other kernels, the minimum loop length is limited by the length of the dependency chain in the processing of stream elements in the inner loops,

¹The instructions included in the IPC shown are those executed on the ALU, MUL, and DSQ units only, and does not include COMM or SP operations. However, IPC but does not translate directly to GOPS since non-arithmetic operations such as SELECTs and SHUFFLEs are included.

making these kernel schedules critical-path limited rather than arithmetic-throughput limited, leading to limited IPC.

In the lower graph in Figure 7.3, the same kernel inner-loop performance data is presented as average arithmetic unit utilization. On this graph, flat lines would correspond to linear speedups for intracluster scaling. Without the use of loop transformations such as software pipelining or loop unrolling, the IPC and utilization data suggests that there would be little advantage to intracluster scaling beyond 2 or 3 ALUs since little additional speedup is achieved for larger clusters. Furthermore, when going from 12 ALUs to 13 ALUs per cluster, a slowdown is observed, due to the additional cycle of latency incurred in traversing the intracluster switch. Without the use of software pipelining or loop unrolling, little ILP can be exploited with intracluster scaling and performance is affected by intracluster switch delay.

Once software pipelining is used, the dependency chain that limited ILP in the kernels above is broken across several iterations of the inner loop, allowing independent processing for several stream elements to occur within the same loop iteration. This significantly increases the amount of ILP available within the inner loops. Average IPC and ALU utilization with software pipelining in these inner loops are shown in Figure 7.4. For N = 2, high ALU utilization of over 75% is achieved for all kernels except for Irast. With this small cluster size, an average IPC of 1.59 is sustained, a speedup of 1.34x over the nonsoftware-pipelined kernels.

As the number of ALUs per cluster is increased, the advantage of these kernels over the non-software-pipelined kernels dramatically increases. In fact, two of the kernels, Noise and Convolve, containing 269 and 146 operations per loop iteration respectively, show near-linear speedups up to 14 ALUs. Irast has the worst average IPC of all kernels because its inner-loop performance is limited by COMM unit throughput, not ALU throughput. For this reason, its performance improves when going from 5 to 6 ALUs and from 10 to 11 ALUs, thresholds for adding COMM units in the scaling model. The remaining three kernels scale to maximum IPCs between 4.1 and 6.4 for 12 ALUs per cluster. These three kernels only contain between 49 and 64 operations per loop iteration and in some cases contain loop-carried state with long dependency chains that can not be broken across loop iterations with software pipelining.



Figure 7.4: Intracluster Scaling with Software Pipelining

7.3. PERFORMANCE EVALUATION

Software pipelining is also effective at creating enough ILP in some kernels to hide the latency of the intracluster switch. Noise and Convolve continue to demonstrate speedups when scaling from 12 to 13 ALUs, in contrast to the slow-downs observed without software pipelining. However, slow-downs are still observable for the Update and FFT kernels, which don't have quite as much ILP.

As shown above, the Blocksad, FFT, and Update kernels scale well to around 5 ALUs per cluster, but beyond that become limited by the amount of ILP and total operation count in each loop iteration. Loop unrolling is a transformation that can help to overcome this by allowing the VLIW compiler to schedule more than one loop iteration at one time. This allows the compiler to interleave ALU operations from subsequent iterations in order to achieve higher ALU utilizations. IPC and ALU utilization results with both loop unrolling and software pipelining on the same suite of kernels are shown in Figure 7.5. From N = 2 to N = 5, the kernel results with software pipelining are nearly identical with and without loop unrolling. However, for N > 5, loop unrolling is effective at improving speedups for the Blocksad, FFT, and Update kernels. For N = 14, loop unrolling improved the average IPC from 5.71 to 6.87. In addition, delay in the intracluster switch does not have a noticeable effect with the use of loop unrolling.

The above data shows that near-linear speedups can be achieved on media processing kernels up to around 10 ALUs per cluster by applying loop transformations and intracluster scaling. However, in order to fairly evaluate the tradeoffs between intracluster and intercluster scaling, performance efficiency (performance per unit area or per unit power) must be considered as well. Figure 7.6 shows the ratio of sustained IPC in kernel inner-loops to processor area for 8-cluster processors. Area is scaled to dimensions typical to a 45 nanometer technology. The three graphs from top to bottom present IPC per square millimeter with no loop transformations, only software pipelining, and both software pipelining and loop unrolling, respectively. Results are shown for all six kernels with the harmonic means in bold. The lower two graphs contain two bold lines: the lower bold line is the harmonic mean of all six kernels while the upper bold line excludes the Irast kernel from the harmonic mean.



Figure 7.5: Intracluster Scaling with Software Pipelining and Loop Unrolling

Without loop transformations, the peak IPC per square millimeter is with 2 ALUs per cluster at 3.82 when averaged over the six kernels. However, the peak performance efficiency improves by 47% when software pipelining is used, providing a peak efficiency of 5.62 with 3 ALUs per cluster. Loop unrolling further increases the peak to 5.76 at 3 ALUs per cluster. In Chapter 6, it was shown that the optimal ratio of peak performance to area was at 5 ALUs per cluster with intracluster scaling. The same result, with an optimal performance efficiency at 5 ALUs, is measured when the Irast kernel is excluded from the analysis. Irast is a kernel limited by COMM unit bandwidth, so does not benefit as much from increasing the ALUs per cluster until more COMM units are also added. The optimal intracluster scaling for performance per unit power (average energy per ALU operation) was presented previously in Chapter 6 and was also shown to be at 5 ALUs.

The kernel performance data presented above demonstrates the effectiveness of intracluster scaling at exploiting various forms of ILP. By applying software pipelining, nearlinear speedups were shown up to 5 ALUs across a broad range of media processing kernels. Further scaling to around 10 ALUs provided good speedups on Noise and Convolve and other kernels with the use of loop unrolling. Performance efficiency measurements show that with the use of software pipelining, the optimal intracluster scaling occurs at between 3 and 5 ALUs per cluster depending on the kernel. Due to limitations in the VLIW compiler, loop-carried state within kernels, intracluster wire delay for N > 12, and reduced area efficiency for N > 5, intracluster scaling is not as effective beyond 5 ALUs per cluster with the use of software pipelining. Although performance efficiencies improve slightly for 4 to 10 ALUs with the use of loop unrolling, this is achieved by converting DLP into ILP.

Intercluster Scaling

Intercluster scaling, on the other hand, is able to directly exploit DLP more efficiently. Intercluster scaling directly exploits DLP by executing more iterations of kernel inner-loops simultaneously in a SIMD fashion. However, just as wire delay and available ILP affected sustained kernel inner-loop performance with intracluster scaling, for intercluster scaling, we have to account for wire delay in the intercluster switch and available DLP. In this section, we explore how intercluster switch delay affects kernel inner-loop performance



Figure 7.6: Inner-Loop Performance per Area with Intracluster Scaling



Figure 7.7: Intercluster Kernel Speedup

and performance efficiency. Limitations on DLP affect application stream lengths, but not kernel inner-loop performance, so the effect of stream lengths on performance will be explored later when discussing application performance in Section 7.3.3.

Holding N fixed at 5 ALUs per cluster, kernel speedups over an 8-cluster processor are shown in Figure 7.7. This data shows the effectiveness of intercluster scaling with the most efficient number of ALUs per cluster, although results would be similar for clusters with different numbers of ALUs. In addition, software pipelining was used for all configurations since this was shown to provide the best efficiencies. As shown in Figure 7.7, as Cincreases, some kernels such as Noise, are perfectly data-parallel and demonstrate perfect speedup. Even kernels such as Irast, which rely heavily on conditional stream and intercluster switch bandwidth, are able to hide intercluster switch latency by taking advantage of available ILP within kernel inner-loops. Based on this kernel inner-loop performance, intercluster scaling is able to achieve near-linear speedups when scaling to 128 clusters.

Performance efficiency results with intercluster scaling are shown in Table 7.2. The table shows total IPC from all C clusters per square millimeter in a 45 nanometer technology. Although peak performance efficiency is achieved with the C = 32 N = 5 configuration at 5.31 IPC per square millimeter, performance per area is relatively unaffected by intercluster scaling until around 64 clusters. Performance per unit area starts to degrade slightly

	Clusters				
Ν	8	16	32	64	128
2	5.23	5.16	5.18	5.05	5.00
5	5.29	5.29	5.31	5.22	4.95
10	4.39	4.47	4.20	4.08	3.81
14	2.68	3.30	3.00	2.88	2.62

 Table 7.2: Intercluster Scaling Performance Efficiency

when scaling to 128 clusters. However, with performance per area of 4.95, the 640-ALU C = 128 N = 5 processor is only 7% worse than the best C = 32 N = 5 processor.

Kernel Inner-Loop Performance Summary

The kernel inner-loop performance data presented above shows that given a fixed area budget, without the use of software pipelining, it would be most efficient to only scale to 2 ALUs per cluster and then to utilize intercluster scaling to provide additional performance. However, even with only 2 ALUs per cluster, the use of software pipelining was shown to provide a 36% performance on inner-loop performance, meaning that this is a loop transformation that provides significant performance gains for all cluster sizes. Once software pipelining is used, intracluster scaling has near-linear speedups up to 10 ALUs on some kernels, although was most efficient at 5 ALUs per cluster for most kernels. Therefore, with the use of software pipelining, it would be most efficient to use intracluster scaling up to 5 ALUs per cluster and to use intercluster scaling, which provides near-linear speedups up to 128 clusters on kernel inner loops, to further improve performance. An optimal performance efficiency was found with 32 clusters and 5 ALUs per cluster, although performance efficiency degraded by only 7% when scaling to 128 clusters.

Whereas software pipelining was shown to be a beneficial loop transformation for all cluster sizes, the case for loop unrolling is less convincing. Loop unrolling shows the most benefit for intracluster scaling for N > 5 and has a negligible impact for $N \ll 5$. Even though loop unrolling increases ILP for these larger clusters, the increase in ILP does not overcome degradations in area efficiency and IPC per square millimeter gradually degrades

from 5.33 to 4.50 when scaling from N = 5 to N = 10. However, loop unrolling and intracluster scaling for the larger clusters is exploiting DLP which could have been exploited with intercluster scaling, yet with much better performance efficiency. This data suggests that intracluster scaling beyond N = 5 would not be as efficient from a performance efficiency standpoint as intercluster scaling to up to 128 clusters.

7.3.2 Kernel Short Stream Effects

Kernel inner-loop performance speedups would reflect application speedups if stream lengths scaled with machine size as the number of ALUs per stream processor are increased. If stream lengths are held constant as machine size increases with intercluster scaling, then the number of loop iterations executed per kernel invocation decreases, so the percentage of runtime spent in kernel inner-loops decreases. If loop unrolling is used with intracluster scaling, the percentage of runtime spent in kernel inner-loops also decreases. In this section, the effect that stream lengths have on kernel performance are measured.

Short stream effects were studied in some detail by Owens et al. [Owens *et al.*, 2002; Owens, 2002], and are similar to performance effects due to short vector lengths in vector processors [Asanovic, 1998]. With short streams, the number of inner loop iterations executed per kernel call decreases, causing a larger fraction of execution time to be spent in loop prologues and epilogues rather than in kernel inner loops. Furthermore, since software pipelining is used extensively to optimize kernel inner-loop performance, a software pipelining priming overhead is incurred with each kernel invocation.

The effect of stream length on kernel performance for a C = 8 processor on four media processing kernels is shown in Figure 7.8. While inner-loop results from Section 7.3.1 showed the achievable IPC with infinitely long streams, meaning a negligible number of cycles are spent outside inner loops, the results in Figure 7.8 show what happens to overall kernel IPC when stream length is taken into account. For each kernel, IPC is shown as stream length, L, is increased from 8 elements to 256 elements. Since C = 8, the number of loop iterations executed per kernel call is given by L/8.

The *None_N2* results show average IPC without the use of software pipelining or loop unrolling for N = 2. In this case, performance is relatively unaffected by stream length



Figure 7.8: Kernel Short Stream Effects

since the loop prologues, bodies, and epilogues are all constrained by limits on true ILP and inter-instruction dependencies within the kernels. Next, results with software pipelining for three cluster sizes (N = 2, 5, and 10) are shown as SWP_N2, SWP_N5, and SWP_N10. In these cases, the kernel scheduler chose the number of software pipeline stages that would minimize the inner loop length. In some of the kernels, up to 6 pipeline stages were used. When software pipelining is used, IPC is much more dependent on stream length than in the none_N2 case, due to the overhead of software pipelining: given stream length L, a kernel inner loop with S software pipeline stages executes L/C + (S-1) times because S-1 iterations are required to prime a software pipelined loop. Finally, two other results are shown: SWP2_N5 and Unroll_N10. SWP2_N5 limits S to a maximum of two stages, meaning kernel inner-loop length is greater than SWP_N5, leading to better IPC for short streams but worse IPC for long streams. Unroll_N10 shows results with the use of software pipelining and loop unrolling for N = 10. It performs worse than SWP_N10 for the same size streams for most kernels, with the exception being Update. Although Unroll_N10 contains shorter inner loops, it executes half as many inner loop iterations as SWP_N10, leading to more software pipelining overhead.

Across the four kernels, for N = 2, the crossover point at which software pipelining improves average kernel IPC is between 16 (Update) and 112 elements (Convolve). Although not shown in the graph, with intracluster scaling, this crossover point shifts down: for N = 5, software pipelining improves IPC across all four kernels for stream lengths of 32 elements or higher. This data suggests that our conclusions for N = 5 being the most efficient cluster organization holds for reasonably sized streams since software pipelining should be used for streams greater than 32 elements, and once software pipelining is used, N = 5, was shown previously in Section 7.3.1 to be the most efficient cluster organization. Further scaling to N = 10 and using loop unrolling to improve inner-loop IPC was shown to be even less efficient when stream lengths are taken into account.

Although the results from Figure 7.8 are specific to a C = 8 processor, from this data, the overall effect intercluster scaling has on kernel performance becomes more clear when stream lengths are taken into account. During applications where dataset size limits stream lengths, such as QRD, intercluster scaling with fixed dataset sizes would reduce stream lengths. With streams significantly longer than the number of clusters, this would have a neglible effect on performance, but for short streams, this could reduce the achieved speedup. For example, in the Update2 kernel (a key part of QRD), as shown in Figure 7.7, an inner-looop speedup of 1.8x was achieved when scaling from 8 to 16 clusters. However, when accounting for short stream effects, the overall kernel speedup would vary from 1.30x to 1.72x for streams of length 32 elements and 512 elements, respectively.

Although short streams could limit speedup on some applications with intercluster scaling with fixed dataset sizes, it is important to note that not all applications incur this performance degradation with intercluster scaling. RENDER, for example, has enough available DLP such that its stream lengths are limited by the capacity of the SRF, not the application dataset. Therefore, its stream lengths are able to scale with the number of clusters and the percentage of runtime in inner loops remains high. Applications such as these or with large datasets (and therefore long streams) will have overall speedups similar to inner-loop performance speedups.

7.3.3 Application Performance

In order to study the effect of intracluster and intercluster scaling on full applications with fixed dataset sizes, the performance on RENDER, DEPTH, CONV, QRD, FFT1K, and FFT4K were evaluated on a range of processor configurations. These results are shown in Figure 7.9, as speedup over a C = 8 N = 5 processor. Sustained performance results in GOPS for the C = 8 N = 5 processor, feasible in today's technology, and the C = 128 N = 10 processor, the highest performing processor, are also annotated for each application assuming a 1 GHz processor clock. All applications except FFT1K and FFT4K assume data is initially in external memory. Since FFTs are typically part of a larger application, their performance was measured with input data already in the SRF, and without simulating the bit-reversed stores on the output data. The C = 128 N = 10 processor has the highest performance with speedups over the C = 8 N = 5 configuration of 20.5x (311 GOPS) on RENDER and 11.6x (328 GOPS) on DEPTH, and a harmonic mean of 10.4x across the six applications.

Intracluster scaling of application performance is similar to kernel performance and is mostly affected by the limited ILP in kernels and increased functional unit latencies. This



Figure 7.9: Application Performance

leads to little application-level speedup or even slow-downs in some cases when increasing N from 10 to 14.

With intercluster scaling, speedups vary considerably depending on the application. With large numbers of clusters and relatively small dataset sizes, some applications suffer from short stream effects. In addition to the short stream effects exhibited during kernel execution described above in Section 7.3.1, as stream lengths decrease relative to C, memory latency and host processor bandwidth also begin to affect performance.

The effect short streams have on application performance with intercluster scaling is evident from the breakdown of execution cycles in RENDER, DEPTH, and QRD, shown in Figure 7.10. Execution cycles are grouped into four categories: kernel inner-loop cycles, kernel non-inner-loop cycles, cycles when kernels are stalled waiting for SRF streams, and cycles when kernels are not active because of memory or host bottlenecks. RENDER is very data-parallel and contains stream lengths limited only by the total number of triangles in a scene. Since this number stays large compared to C, the ratio of kernel inner-loop iterations to kernel invocations stays high, and over 80% of runtime is devoted to processing from kernel inner loops. As a result, RENDER scales very well to large numbers of clusters.

DEPTH also contains abundant data parallelism, however does not scale quite as well as RENDER due to short stream effects and SIMD overheads. When streams contain only pixels from one row of the input image, SIMD overheads (extra instructions executed in the kernel inner loops per cluster) are small, but short stream effects cause a large percentage of run-time to be spent in non-inner-loop kernel cycles, as seen in Figure 7.10 when going from 8 to 16 clusters. For 32 clusters, the application is restructured so that each stream contains pixels from 16 rows at a time, rather than the single row which was used for 8 and 16 clusters. The result is that over 95% of runtime is spent in the inner loops. However, the operation count per inner loop is higher when clusters operate on streams that contain pixels from more than one row in SIMD. Consequently, there is a sub-linear speedup from 8 to 32 clusters on DEPTH. The advantage of multiple-row DEPTH becomes apparent when scaling to 64 and 128 clusters: short stream effects are avoided and large amounts of data parallelism can be exploited.

With QRD, the matrix block update kernels scale well and if the datasets grew with C, QRD performance would scale similarly. However, with a fixed-size dataset, the larger



Figure 7.10: Application Cycles with Intercluster Scaling (N=5)

machines spend an increasing fraction of their runtime computing the orthogonal bases for the decomposition, a step which scales poorly, therefore limiting speedup. In addition to algorithmic inefficiencies leading to poor speedups, QRD with a fixed 256x256 dataset-size also suffers from short stream effects, as can be seen in Figure 7.10, with a large percentage of cycles spent outside of kernel inner-loops.

Direct evidence for performance degradation due to short stream effects is apparent when comparing FFT4K to FFT1K in Figure 7.9. Although FFT4K has lower performance than FFT1K at C = 8 N = 5 because its large working set requires spilling from the SRF to memory, at C = 128 N = 10, the difference in raw performance between FFT4K and FFT1K is due purely to stream length. On a C = 128 N = 10 processor, FFT4K sustains 211 GFLOPS, while FFT1K, containing shorter streams, only sustains 103 GFLOPS.

In summary, the advantages of intracluster scaling to exploit ILP and provide optimal efficiency at 5 ALUs per cluster were apparent from kernel inner-loop performance. Similar speedups in the intracluster scaling dimension were also achieved with full applications. With intercluster scaling, kernel inner-loop performance results showed the ability to take advantage of DLP in kernels with near-linear speedups up to 128 clusters on many kernels. These kernel performance speedup numbers suggest how media application performance would scale if dataset size scaled with machine size. However, with fixed dataset sizes, limited DLP in some applications leads to short streams. Nevertheless, even with these datasets, a 1280-ALU C = 128 N = 10 processor is able to sustain an average of 200 GOPS over six applications, a speedup of 10.4x over a 40-ALU C = 8 N = 5 processor.

7.3.4 Bandwidth Hierarchy Scaling

The tradeoffs between intracluster and intercluster scaling demonstrate the ability to exploit available ILP and DLP in media applications. However, not only must parallelism be exploited, but a processor must exploit both the compute intensity and locality in media applications in order to achieve high performance. With both intracluster and intercluster scaling, the data bandwidth hierarchy has been scaled to exploit the available locality. This is accomplished by increasing the LRF and SRF size and capacity as specified in Chapter 6.


Figure 7.11: Bandwidth Hierarchy with Intercluster Scaling (N=5)

This scalable data bandwidth hierarchy in the stream architecture enables GFLOPs of arithmetic performance to be sustained with modest off-chip memory bandwidth requirements.

The scalability of the data bandwidth hierarchy is shown on a logarithmic scale in Figure 7.11. With eight arithmetic clusters, between 380 and 565 GB/s of LRF bandwidth, between 11 and 42 GB/s of SRF bandwidth, and between 0.33 and 2.87 GB/s of memory bandwidth are necessary in the RENDER, DEPTH, and QRD applications. As intercluster scaling is used to scale to 128 clusters, the LRF bandwidth demands grow by over an order of magnitude to between 5.9 and 7.0 TB/s. However, since the SRF bandwidth and capacity is also increased with the number of ALUs, the bandwidth hiearchy is able to handle this increased LRF bandwidth. During RENDER, memory bandwidth is used only for input and output operations, so its memory and SRF bandwidth scales as the same rate as the LRFs. However, for DEPTH and QRD, with increased SRF capacity, additional locality can be captured in the SRF, avoiding memory spills required in the smaller processors.

Since LRF and SRF bandwidth and capacity are increased appropriately with intracluster and intercluster scaling, the data bandwidth hierarchy is able to scale effectively to hundreds of ALUs per stream processor. This scalablity allows for high sustained arithmetic throughputs with hundreds of ALUs per stream processor with modest off-chip memory systems. Furthermore, the scalability of the data bandwidth hierarchy means that over 95% of data accesses in these future stream processors are made to the LRFs, not to the SRF or external memory, leading to energy-efficient execution of these media applications.

7.4 Improving Intercluster and Intracluster Scalability

The results presented in Chapter 6 demonstrated the scalability of stream processors to hundreds of arithmetic units with a less than 10% degradation in efficiency. For example, a 640-ALU C = 128 N = 5 stream processor requires only 2% more area per ALU and only 7% more energy per ALU operation than a 40-ALU C = 8 N = 5 stream processor. Furthermore, the results from this chapter demonstrated near-linear speedup on kernel inner-loop performance when comparing a 640-ALU and 40-ALU processor. However, it is worth considering whether additional microarchitectural optimizations in large stream processors such as a 640-ALU processor could lead to area and energy efficiencies equal

or better to a 40-ALU processor.

With slight modifications to the software tools and to microarchitecture used for intracluster and intercluster scaling, area and energy efficiency could potentially be improved. The two structures that stand out as not scaling as efficiently as the rest of the processor and that could be improved are the intracluster and intercluster switches.

Several optimizations could be made to improve the intracluster switch. First, by adding control bits to the intracluster switch, instead of broadcasting functional-unit outputs to all LRF inputs, some bus segments could be disabled on a cycle-by-cycle basis in order to save power. Second, area could be saved by using an explicitly scheduled sparse crossbar for the intracluster switch. Currently, the kernel compiler requires a full crossbar connecting the outputs of functional units to inputs of the LRFs in order to achieve high efficiencies in kernel inner loops. However, with some kernel compiler improvements, a sparse crossbar would reduce the area of the switch as the number of ALUs per cluster increased and would have the potential to increase the number of ALUs per cluster that achieved optimal performance efficiencies on a range of ALUs. Although most kernels would have to convert DLP to ILP with loop unrolling to have performance scale effectively beyond 5 ALUs per cluster, some kernels have enough ILP to take advantage of the additional parallelism that could be enabled with an efficient intracluster switch.

The switch is the limiting structure in intercluster scaling as well. A sparse crossbar for the intercluster switch could further improve area and energy efficiency for larger numbers of clusters. In the intercluster case, the communication across the switch is input from the programmer and is based on communication patterns required in the applications.

Just as locality could be exploited by the VLIW compiler in the intracluster switch, if locality exists in intercluster communication patterns, a switch that could exploit this to improve area and energy efficiency. The available locality in intercluster communications was studied by looking at the 13 permutations from the kernel inner-loops in DEPTH, FFT, and QRD on 64-cluster machines. An 8x8 cluster grid floorplan was assumed, where clusters 0 through 7 are in column 0, clusters 8 through 15 are in column 1, and so on up to clusters 56 to 63 in column 7. Given this floorplan, the histogram shown in Figure 7.12 demonstrates the locality in these permutation patterns. Since 13 permutations are studied, 832 total communications are grouped into 15 categories based on the number of hops



Figure 7.12: Intercluster Switch Locality with 8x8 Cluster Grid Floorplan

which must be traveled between clusters. Note that in an 8x8 grid, the maximum number of hops is 14. This histogram shows that indeed some locality exists as the most common case is 4 hops and only 6.5% of communications require greater than 8 hops.

Future research could explore intercluster switch topologies that could provide better area and energy efficiency by exploiting the locality between clusters during communications. One example of a switch topology for an 8x8 cluster grid that exploits this locality is shown in Figure 7.13. Similar to the full crossbar shown in Figure 6.1, in this figure, each cluster broadcasts its output across its row bus and reads an input onto its column bus. However, in this topology, row and column buses span only 2 clusters in each direction, meaning communications are limited to four hops maximum. Permutations with maximum hop counts greater than 4 would require more than one communication to route the data succesfully, leading to more required switch bandwidth in some kernels. However, this topology has an area-efficiency advantage over a full crossbar because it only requires five buses per column and per row, whereas a full crossbar requires eight buses per column and



Figure 7.13: Limited-Connectivity Inercluster Switch for 8x8 Cluster Floorplan

per row. Future research could explore the tradeoff between performance and efficiency for this and other switch topologies.

7.5 Scalability Summary

As technology enables more ALUs to fit on a single chip, architectures must efficiently utilize bandwidth in order to achieve large performance gains. In this chapter, two scaling techniques for stream processors that enable large performance gains on media processing applications in future VLSI technologies were presented. Intracluster scaling was shown to be effective from a performance and cost standpoint up to 10 ALUs per cluster, although was most efficient at 5 ALUs per cluster. This optimal efficiency at 5 ALUs per cluster is derived from amortizing fixed cluster costs such as streambuffers, the intercluster switch ports, and the scratchpad over more ALUs. Meanwhile, near-linear speedups are achievable up to 5 ALUs with the use of software pipelining. Beyond 5 ALUs, the ILP available from software pipelining trails off and the cost of the intracluster switch and additional required intercluster switch port hurts efficiency. Intercluster scaling was shown to be effective up to 128 clusters, with only a slight decrease in area and energy efficiency. In addition, a variety of media applications were shown to have significant parallelism and no prohibitive limits on inherent stream lengths in the application, thereby enabling speedups of up to 27.4x and 10.0x when comparing a 1280-ALU to a 40-ALU stream processor on a harmonic mean of kernels and applications.

Chapter 8

Conclusions

In this dissertation, stream processors were shown to achieve performance rates and performance efficiencies significantly higher than other programmable processors on media applications, and approaching the efficiencies of fixed-function processors. The Imagine architecture, the first VLSI implementation of a stream processor, is able to achieve high performance and efficiencies by exploiting large amounts of parallelism, by exploiting locality to effectively manage data bandwidth, and by the use of area- and energy-efficient register organization.

Furthermore, the architectural concepts and performance measurements validated with the Imagine stream processor can be extended to future technologies using the intercluster and intracluster scaling techniques presented in this dissertation. The analysis presented in this work demonstrates the scalability of stream processors to thousands of arithmetic units in future VLSI technologies with comparable performance efficiencies to stream processors containing tens of arithmetic units. These future stream processors will be capable of sustaining hundreds of billions of arithmetic operations per second while maintaining high performance efficiencies, enabling a large set of new and existing real-time media applications in a wide variety of mobile, desktop, and server systems, while retaining the advantages of programmability.

8.1 Future Work

The work described here leads to a number of other interesting areas of future research:

Imagine System

Although this dissertation presents the design and implementation of the Imagine processor, one important area of future work is in system design for the Imagine stream processor. The experimental measurements described in Chapter 5 were obtained with a PCI board containing two Imagine processors, a host processor, glue-logic FPGAs, and DRAM chips. At the time this dissertation was submitted, this board was not able to run all available media applications at real-time due to host-processor and glue-logic limitations (not because of host interface bandwidth limitations on the Imagine processor). Future work is underway to redesign a board which eliminates these limitations enabling real-time execution of a larger range of media applications. Another ongoing area of research is multiprocessor systems using the Imagine network interface. This research would lead to a number of key insights into performance, software tools, and host processor requirements in these multi-Imagine systems.

Applications

In this dissertation, the evaluation of stream processing was restricted to media processing requirements with today's workloads and datasets. However, as stream processors scale to Teraops of performance with high performance efficiencies, such processors will provide the potential for running more complex media processing algorithms and much larger datasets at real-time rates. For example, in computer graphics, polygon rendering with higher scene complexity and screen resolutions would require larger datasets and more performance to achieve real-time rates. Furthermore, raytracing and image-based rendering techniques have been emerging as alternative applications for computer graphics also requiring higher performance than polygon rendering. These trends suggest that as available media processor performance increases, media applications and their datasets will evolve to take advantage of this available performance while sustaining real-time rates. Therefore, an important area of future work would be to explore how media processors can scale in a

way to provide the types of performance rates required for future media applications, rather than today's applications.

Another area of future work for applications of stream processors is in broadening the application domains. Recent work has started to explore the effectiveness of stream processing to both scientific workloads [Dally *et al.*, 2001] and signal processing for wireless communications [Rajagopal *et al.*, 2002]. Such application domains share many of the same application characteristics as media applications, but differ slightly, meaning that enhancements and optimizations to the stream processor architecture and microarchitecture could be made to improve performance and VLSI efficiency on these applications.

VLSI Efficient Stream Processing

The VLSI efficiency of stream processing stems from the stream register organization that allows for efficient use of parallelism and locality and media applications. One area of future work would be to explore enhancements to this register organization that could further improve the VLSI efficiency of stream processors. Such enhancements were briefly discussed in Chapter 7 with studies into non-fully-interconnected intercluster switches. However, other possibilities for improvement include a non-fully-interconnected intracluster switch and slightly modified local register file structures. For example, rather than using two dual-ported register files per arithmetic unit, other structures such as one multi-ported register file per arithmetic unit could be explored. Although such a structure would require more interconnectivity in the read and write ports, such a design might be more efficient if this interconnect could be overlapped with memory cells and other transistors in this register file design. This and other improvements to the register organization could be explored to achieve small improvements in the VLSI efficiency of stream processing.

Scalability

A final area of future work involves scalability to large numbers of arithmetic units per chip in future technologies. In this dissertation, the two techniques of intracluster and intercluster scaling were presented and evaluated. These two dimensions of scaling are able to exploit instruction-level and data-level parallelism respectively. However, a third dimension of scaling is also possible, in the task-level (or thread-level) dimension. This scaling technique would involve either multiple kernel execution units (microcontroller with some number of clusters) connected to a single stream register file or multiple stream processor cores on a single chip. In these architectures, multiple kernels could be executing simultaneously, thereby exploiting task-level parallelism. As software tools for exploiting task-level parallelism could be exploiting task-level parallelism.

In summary, the work presented in this thesis describes the first VLSI implementation of a stream processor and describes scaling techniques that show the viability of stream processing for many years to come. This is an area of research that is just beginning and will lead to new and exciting results in the areas of real-time media processing and powerefficient computer architecture.

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